

MC68HC05P6

TECHNICAL DATA



MC68HC05P6 HCMOS MICROCONTROLLER UNIT

Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters can and do vary in different applications. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use a components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death Motorola was negligent regarding the design or manufacture of the part. Motorola and (A) are registered trademarks of Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer.

TABLE OF CONTENTS

Paragraph

Title

Page

SECTION 1 GENERAL DESCRIPTION

| 1.1 | Features | 1-1 |
|---------|-------------------------------------|------|
| 1.2 | Mask Options | 1-2 |
| 1.3 | MCU Structure | 1-3 |
| 1.4 | Pin Assignments | 1-4 |
| 1.4.1 | V _{DD} and V _{SS} | 1-4 |
| 1.4.2 | OSC1 and OSC2 | 1-5 |
| 1.4.2.1 | Crystal | 1-5 |
| 1.4.2.2 | Ceramic Resonator | 1-6 |
| 1.4.2.3 | RC Oscillator | 1-7 |
| 1.4.2.4 | External Clock | 1-8 |
| 1.4.3 | RESET | 1-8 |
| 1.4.4 | IRQ | 1-8 |
| 1.4.5 | PA7–PA0 | 1-9 |
| 1.4.6 | PB7/SCK | 1-9 |
| 1.4.7 | PB6/SDI | 1-9 |
| 1.4.8 | PB5/SDO | 1-9 |
| 1.4.9 | PC7/V _{RH} | 1-9 |
| 1.4.10 | PC6/AN0 | 1-9 |
| 1.4.11 | PC5/AN1 | 1-9 |
| 1.4.12 | PC4/AN2 | |
| 1.4.13 | PC3/AN3 | |
| 1.4.14 | PC2–PC0 | 1-10 |
| 1.4.15 | PD7/TCAP | 1-10 |
| 1.4.16 | PD5 | |
| 1.4.17 | ТСМР | |

SECTION 2 MEMORY

| 2.1 | Memory Map | 2-1 |
|-----|----------------------|-----|
| 2.2 | Input/Output Section | 2-1 |
| 2.3 | RAM | 2-1 |
| 2.4 | ROM | 2-4 |
| 2.5 | Self-Check ROM | 2-4 |

MOTOROLA

Freestale Sernit Jaduetor, Inc. (Continued)

3.1

Title

Page

SECTION 3

CENTRAL PROCESSOR UNIT (CPU)

| 3.1.1 | Accumulator | 3-2 |
|---------|-----------------------------|-----|
| 3.1.2 | Index Register | |
| 3.1.3 | Stack Pointer | 3-3 |
| 3.1.4 | Program Counter | 3-4 |
| 3.1.5 | Condition Code Register | 3-4 |
| 3.1.5.1 | Half-Carry Flag (H) | 3-5 |
| 3.1.5.2 | Interrupt Mask (I) | 3-5 |
| 3.1.5.3 | Negative Flag (N) | 3-5 |
| 3.1.5.4 | Zero Flag (Z) | 3-5 |
| 3.1.5.5 | Carry/Borrow Flag (C) | 3-5 |
| 3.2 | Arithmetic/Logic Unit (ALU) | |

SECTION 4 INTERRUPTS

| 4.1 | Interrupt Sources | 4-1 |
|---------|--------------------------|-----|
| 4.1.1 | Software Interrupt | 4-1 |
| 4.1.2 | External Interrupt | 4-1 |
| 4.1.3 | Timer Interrupts | 4-3 |
| 4.1.3.1 | Input Capture Interrupt | |
| 4.1.3.2 | Output Compare Interrupt | |
| 4.1.3.3 | Timer Overflow Interrupt | |
| 4.2 | Interrupt Processing | |

SECTION 5 RESETS

| 5.1 | Reset Sources | 5-1 |
|-------|--|-----|
| 5.1.1 | Power-On Reset | 5-1 |
| 5.1.2 | External Reset | 5-1 |
| 5.1.3 | Computer Operating Properly (COP) Watchdog Reset | 5-2 |
| 5.2 | Reset States | 5-3 |
| 5.2.1 | CPU | 5-3 |
| 5.2.2 | I/O Port Registers | 5-3 |
| 5.2.3 | Capture/Compare Timer | 5-3 |
| 5.2.4 | Serial I/O Port (SIOP) | 5-4 |
| 5.2.5 | COP Watchdog | 5-4 |
| 5.2.6 | Analog-to-Digital Converter (ADC) | 5-4 |
| | | |

For More Information On This Product, Go to: www.freescale.com

iv

MC68HC05P6

LL.

FARISE alf SemicEndictor, Inc. (Continued)

Paragraph

Semiconductor, Inc.

Freescale

Title

Page

SECTION 6 LOW POWER MODES

| 6.1 | Stop Mode | 6-1 |
|-----|---------------------|-----|
| 6.2 | Wait Mode | 6-2 |
| 6.3 | Halt Mode | 6-3 |
| 6.4 | Data-Retention Mode | 6-3 |

SECTION 7 PARALLEL I/O

| 7.1 | I/O Port Function | 7-1 |
|-------|----------------------------------|------|
| 7.2 | Port A | 7-1 |
| 7.2.1 | Port A Data Register (PORTA) | 7-1 |
| 7.2.2 | Data Direction Register A (DDRA) | 7-2 |
| 7.3 | Port B | 7-4 |
| 7.3.1 | Port B Data Register (PORTB) | 7-4 |
| 7.3.2 | Data Direction Register B (DDRB) | |
| 7.4 | Port C | |
| 7.4.1 | Port C Data Register (PORTC) | 7-7 |
| 7.4.2 | Data Direction Register C (DDRC) | 7-8 |
| 7.5 | Port D | 7-10 |
| 7.5.1 | Port D Data Register (PORTD) | |
| 7.5.2 | Data Direction Register D (DDRD) | |
| | – , , , | |

SECTION 8 CAPTURE/COMPARE TIMER

| 8.1 | Timer Operation | 8-2 |
|-------|---|-----|
| 8.1.1 | Input Capture | |
| 8.1.2 | Output Compare | 8-3 |
| 8.2 | Timer I/O Registers | 8-4 |
| 8.2.1 | Timer Control Register (TCR) | 8-5 |
| 8.2.2 | Timer Status Register (TSR) | 8-6 |
| 8.2.3 | Timer Registers (TRH and TRL) | 8-7 |
| 8.2.4 | Alternate Timer Registers (ATRH and ATRL) | 8-8 |
| 8.2.5 | Input Capture Registers (ICRH and ICRL) | 8-9 |
| 8.2.6 | Output Compare Registers (OCRH and OCRL) | |
| | | |

FF885Ea@FS6AND5AduStor, Inc. (Continued)

MOTOROLA

Page

SECTION 9 SERIAL I/O PORT (SIOP)

Title

| 9.1 | SIOP Operation | |
|-------|-----------------------------|-----|
| 9.1.1 | SIOP Pin Functions | |
| 9.1.2 | Serial Clock | 9-3 |
| 9.1.3 | Data Movement | 9-4 |
| 9.2 | SIOP I/O Registers | 9-4 |
| 9.2.1 | SIOP Control Register (SCR) | 9-4 |
| 9.2.2 | SIOP Status Register (SSR) | 9-5 |
| 9.2.3 | SIOP Data Register (SDR) | 9-6 |

SECTION 10 ANALOG-TO-DIGITAL CONVERTER (ADC)

| ADC Operation | |
|---|---|
| | |
| PC7/V _{RH} | |
| PC6/AN0, PC5/AN1, PC4/AN2, and PC3/AN3 | |
| Conversion Accuracy | |
| Conversion Time | |
| Internal RC Oscillator | |
| ADC I/O Registers | |
| ADC Status and Control Register (ADSCR) | |
| ADC Data Register (ADDR) | |
| | PC7/V _{RH} PC6/AN0, PC5/AN1, PC4/AN2, and PC3/AN3 Conversion Accuracy Conversion Time Internal RC Oscillator ADC I/O Registers ADC Status and Control Register (ADSCR) |

SECTION 11 SELF-CHECK ROM

| 11.1 | Self-Check Tests | 11-1 |
|------|--------------------|------|
| 11.2 | Self-Check Results | 11-1 |
| 11.3 | Self-Check Circuit | 11-2 |

SECTION 12 INSTRUCTION SET

| 12.1 | Addressing Modes | |
|--------|------------------|--|
| | Inherent | |
| 12.1.2 | Immediate | |
| 12.1.3 | Direct | |
| 12.1.4 | Extended | |

MC68HC05P6

reescale

LL.

Paragraph

(Continued)

MC68HC05P6

Paragraph

Title

| 12.1.5 | Indexed, No Offset | |
|--------|--------------------------------|--|
| 12.1.6 | Indexed, 8-Bit Offset | |
| 12.1.7 | Indexed, 16-Bit Offset | |
| 12.1.8 | Relative | |
| 12.2 | Instruction Types | |
| 12.2.1 | Register/Memory Instructions | |
| 12.2.2 | Read-Modify-Write Instructions | |
| 12.2.3 | Jump/Branch Instructions | |
| 12.2.4 | Bit Manipulation Instructions | |
| 12.2.5 | Control Instructions | |
| 12.3 | Instruction Set Summary | |
| 12.4 | Opcode Map | |

SECTION 13 ELECTRICAL SPECIFICATIONS

| 13.1 | Maximum Ratings | |
|-------|---|--|
| 13.2 | Thermal Characteristics | |
| 13.3 | Power Considerations | |
| 13.4 | DC Electrical Characteristics (V _{DD} = 5.0 Vdc) | |
| 13.5 | DC Electrical Characteristics (V _{DD} = 3.3 Vdc) | |
| 13.6 | ADC Characteristics | |
| 13.7 | Control Timing (V _{DD} = 5.0 Vdc) | |
| 13.8 | Control Timing (V _{DD} = 3.3 Vdc) | |
| 13.9 | SIOP Timing (V _{DD} = 5.0 Vdc) | |
| 13.10 | SIOP Timing (V _{DD} = 3.3 Vdc) | |

SECTION 14 MECHANICAL SPECIFICATIONS

| 14.1 | PDIP | 14-1 |
|------|------|------|
| 14.2 | SOIC | 14-2 |

Semiconductor, Inc.

MOTOROLA vii

Fre**EABLE StrincONTEXTOR**, Inc. (Concluded)

Section

Title

Page

SECTION 15 ORDERING INFORMATION

| 15.1 | MCU Ordering Forms | 5-1 |
|--------|-------------------------------|---------|
| 15.2 | Application Program Media | 5-2 |
| 15.2.1 | Diskettes | 5-2 |
| 15.2.2 | EPROMs | 5-3 |
| 15.3 | ROM Program Verification | 5-4 |
| 15.4 | ROM Verification Units (RVUs) | 5-5 |
| 15.5 | XC Status Letter | 5-5 |

MC68HC05P6

LIST OF FIGURES

| Figure | Title | Page |
|--------|----------------------------------|------|
| 1-1 | MC68HC05P6 Block Diagram | 1-3 |
| 1-2 | Pin Assignments | |
| 1-3 | Bypassing Layout Recommendation | 1-5 |
| 1-4 | Crystal Connections | |
| 1-5 | Ceramic Resonator Connections | 1-7 |
| 1-6 | RC Oscillator Connections | |
| 1-7 | External Clock Connections | 1-8 |
| 2-1 | Memory Map | 2-2 |
| 2-2 | I/O Registers | 2-3 |
| 3-1 | Programming Model | |
| 3-2 | Accumulator | |
| 3-3 | Index Register | |
| 3-4 | Stack Pointer | 3-3 |
| 3-5 | Program Counter | |
| 3-6 | Condition Code Register | 3-4 |
| 4-1 | External Interrupt Logic | |
| 4-2 | Interrupt Stacking Order | |
| 4-3 | Interrupt Flowchart | 4-6 |
| 5-1 | Reset Sources | 5-2 |
| 5-2 | COP Register (COPR) | 5-2 |
| 6-1 | STOP/HALT/WAIT Flowchart | 6-4 |
| 7-1 | Port A Data Register (PORTA) | 7-2 |
| 7-2 | Data Direction Register A (DDRA) | 7-2 |
| 7-3 | Port A I/O Circuit | |
| 7-4 | Port B Data Register (PORTB) | 7-4 |
| 7-5 | Data Direction Register B (DDRB) | 7-5 |
| 7-6 | Port B I/O Circuit | |

Semiconductor, Inc.

Freescale

MC68HC05P6

LIST OF FIGURES Freescale Semiconductor, Inc.

| Figure | Title | Page |
|------------|--|------|
| 7-7 7-8 | Port C Data Register (PORTC) Data Direction Register C (DDRC) | 7-8 |
| 7-9 | Port C I/O Circuit | |
| 7-10 | Port D Data Register (PORTD) | |
| 7-11 | Data Direction Register D (DDRD) | |
| 7-12 | Port D I/O Circuit | 7-12 |
| 8-1 | Timer Block Diagram | 8-1 |
| 8-2 | Input Capture Operation | 8-3 |
| 8-3 | Output Compare Operation | 8-4 |
| 8-4 | Timer Control Register (TCR) | 8-5 |
| 8-5 | Timer Status Register (TSR) | |
| 8-6 | Timer Registers (TRH and TRL) | 8-7 |
| 8-7 | Timer Register Reads | |
| 8-8 | Alternate Timer Registers (ATRH and ATRL) | 8-8 |
| 8-9 | Alternate Timer Register Reads | 8-9 |
| 8-10 | Input Capture Register (ICRH/ICRL) | |
| 8-11 | Output Compare Registers (OCRH and OCRL) | |
| 9-1 | SIOP Block Diagram | 9-1 |
| 9-2 | SIOP Data/Clock Timing | |
| 9-3 | Master/Slave SIOP Shift Register Operation | 9-4 |
| 9-4 | SIOP Control Register (SCR) | |
| 9-5 | SIOP Status Register (SCR) | 9-5 |
| 9-6 | SIOP Data Register (SDR) | 9-6 |
| 10-1 | ADC Block Diagram | 10-1 |
| 10-2 | ADC Status and Control Register (ADSCR) | |
| 10-3 | ADC Data Register (ADDR) | |
| 11-1 | Self-Check Circuit | 11-2 |
| 13-1 | Test Load | |
| 13-2 | I _{DD} vs Internal Clock Frequency (T = 25 °C) | |
| 13-3 | I_{DD} vs Internal Clock Frequency (T = -40 °C to +125 °C) | |

MOTOROLA

MC68HC05P6

Freescale Semiconductor, Inc. (Concluded)

Figure

Page

| 13-4 | TCAP Timing | |
|------|---------------------------|--|
| 13-5 | STOP Recovery Timing | |
| 13-6 | External Interrupt Timing | |
| 13-7 | Power-On Reset Timing | |
| 13-8 | External Reset Timing | |
| 13-9 | SIOP Timing | |
| 14-1 | Case #710-02 | |
| 14-2 | Case #751F-02 | |

Title

MC68HC05P6

xi

MOTOROLA xii MC68HC05P6

LIST OF TABLES

Table

Title

Page

| 4-1 | Reset/Interrupt Vector Addresses4-5 |
|-------|---|
| 7-1 | Port A Pin Functions7-4 |
| 7-2 | Port B Pin Functions7-6 |
| 7-3 | Port C Pin Functions7-9 |
| 7-4 | Port D Pin Functions |
| 10-1 | ADC Input Channel Selection 10-5 |
| 11-1 | Self-Check Circuit LED Codes |
| 12-1 | Inherent Addressing Instructions 12-2 |
| 12-2 | Immediate Addressing Instructions 12-3 |
| 12-3 | Direct Addressing Instructions12-4 |
| 12-4 | Extended Addressing Instructions12-5 |
| 12-5 | Indexed Addressing Instructions12-7 |
| 12-6 | Relative Addressing Instructions12-8 |
| 12-7 | Register/Memory Instructions12-9 |
| 12-8 | Read-Modify-Write Instructions12-10 |
| 12-9 | Jump and Branch Instructions12-11 |
| 12-10 | Bit Manipulation Instructions |
| 12-11 | Control Instructions |
| 12-12 | Instruction Set12-14 |
| 13-1 | Maximum Ratings13-1 |
| 13-2 | Thermal Resistance13-1 |
| 13-3 | DC Electrical Characteristics (V _{DD} = 5.0 Vdc) |
| 13-4 | DC Electrical Characteristics (V _{DD} = 3.3 Vdc) |
| 13-5 | A/D Converter Characteristics13-7 |
| 13-6 | Control Timing (V _{DD} = 5.0 Vdc) |
| 13-7 | Control Timing (V _{DD} = 3.3 Vdc) |
| 13-8 | SIOP Timing (V _{DD} = 5.0 Vdc) |
| 13-9 | SIOP Timing (V _{DD} = 3.3 Vdc) |

MC68HC05P6

MOTOROLA xiv MC68HC05P6

SECTION 1 GENERAL DESCRIPTION

The MC68HC05P6 is a member of the low-cost, high-performance M68HC05 Family of 8-bit microcontroller units (MCUs). The M68HC05 Family is based on the customer-specified integrated circuit (CSIC) design strategy. All MCUs in the family use the popular M68HC05 central processor unit (CPU) and are available with a variety of subsystems, memory sizes and types, and package types.

On-chip memory of the MC68HC05P6 includes 176 bytes of user RAM and 4672 bytes of user ROM.

1.1 Features

Features of the MC68HC05P6 MCU include the following:

- Popular M68HC05 Central Processor Unit
- Memory-Mapped Input/Output (I/O) Registers
- 4672 Bytes of User ROM Including 48 Bytes of Page Zero ROM and 16 User Vector Locations
- 176 Bytes of User RAM
- 20 I/O Port Pins and One Input-Only Port Pin
- On-Chip Oscillator with Crystal or Ceramic Resonator Connections or Resistor-Capacitor (RC) Connections
- 4-Input, 8-Bit Analog-to-Digital Converter (ADC)
- Synchronous Serial I/O Port (SIOP)
- 16-Bit Capture/Compare Timer
- Fully Static Operation with No Minimum Clock Speed
- Self-Check ROM
- Computer Operating Properly (COP) Watchdog
- Power-Saving Stop (or Halt), Wait, and Data-Retention Modes
- 8 × 8 Unsigned Multiply Instruction
- 28-Pin Plastic Dual In-Line Package (PDIP)
- 28-Pin Small Outline Integrated Circuit (SOIC)

MC68HC05P6

GENERAL DESCRIPTION

1.2 Mask Options **Freescale Semiconductor, Inc.**

The following MC68HC05P6 mask options are available:

- On-chip oscillator connections: crystal/ceramic resonator connections or resistor-capacitor (RC) network connections
- STOP instruction: enabled or disabled
- SIOP clock rate: oscillator frequency divided by 8, 16, 32, or 64
- SIOP data format: MSB-first or LSB-first
- External interrupt pin: edge-triggered or edge- and level-triggered
- COP watchdog: enabled or disabled

MOTOROLA 1-2

GENERAL DESCRIPTION

MC68HC05P6

1.3 MCU Structure Freescale Semiconductor, Inc.

Figure 1-1 shows the structure of the MC68HC05P6 MCU.

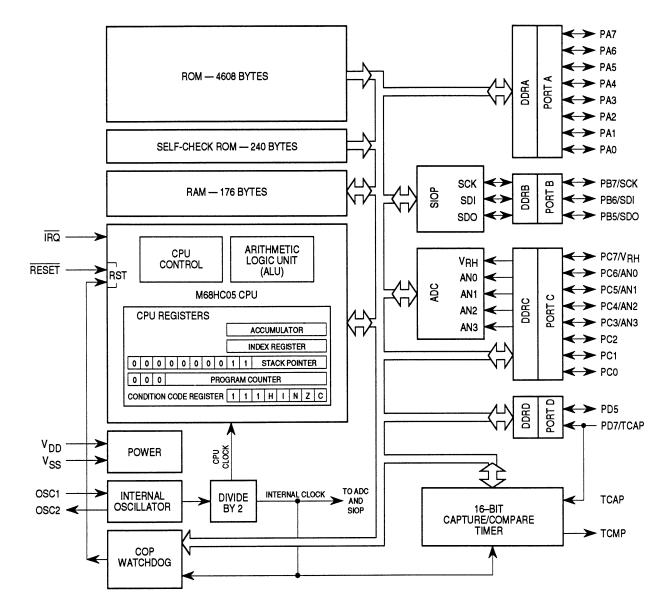


Figure 1-1. MC68HC05P6 Block Diagram

MC68HC05P6

GENERAL DESCRIPTION

MOTOROLA 1-3

1.4 Pin Assignments Freescale Semiconductor, Inc.

Figure 1-2 shows the MC68HC05P6 pin assignments.

| | I | | | 1 | |
|-----------------|---|----|----|---|---------------------|
| RESET | d | 1 | 28 | þ | V _{DD} |
| IRQ | þ | 2 | 27 | þ | OSC1 |
| PA7 | þ | 3 | 26 | þ | OSC2 |
| PA6 | q | 4 | 25 | þ | PD7/TCAP |
| PA5 | þ | 5 | 24 | þ | ТСМР |
| PA4 | þ | 6 | 23 | þ | PD5 |
| PA3 | þ | 7 | 22 | þ | PC0 |
| PA2 | q | 8 | 21 | þ | PC1 |
| PA1 | þ | 9 | 20 | þ | PC2 |
| P A 0 | þ | 10 | 19 | þ | PC3/AN3 |
| PB5/SDO | þ | 11 | 18 | þ | PC4/AN2 |
| PB6/SDI | þ | 12 | 17 | þ | PC5/AN1 |
| PB7/SCK | þ | 13 | 16 | þ | PC6/AN0 |
| V _{SS} | q | 14 | 15 | þ | PC7/V _{RH} |

Figure 1-2. Pin Assignments

1.4.1 V_{DD} and V_{SS}

 V_{DD} and V_{SS} are the power supply and ground pins. The MCU operates from a single 5 V power supply.

Very fast signal transitions occur on the MCU pins, placing very high short-duration current demands on the power supply. To prevent noise problems, take special care to provide good power supply bypassing at the MCU. Place bypass capacitors as close to the MCU as possible, as Figure 1-3 shows. C2 is an optional bulk current bypass capacitor for use in applications that require the port pins to source high current levels.

MOTOROLA

1-4

GENERAL DESCRIPTION

MC68HC05P6

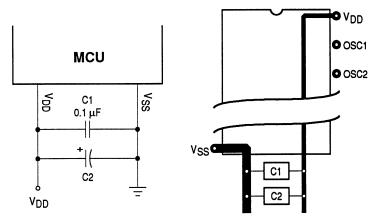


Figure 1-3. Bypassing Layout Recommendation

1.4.2 OSC1 and OSC2

The OSC1 and OSC2 pins are the control connections for the on-chip oscillator. Depending on the mask option selected, the oscillator can be driven by any of the following:

- Crystal
- Ceramic resonator
- Resistor-capacitor network
- External clock signal

The frequency of the internal oscillator is f_{OSC} . The MCU divides the internal oscillator output by two to produce the internal clock. The frequency of the internal clock is f_{OP} .

1.4.2.1 Crystal

With the crystal/ceramic resonator mask option, a crystal connected to the OSC1 and OSC2 pins can drive the on-chip oscillator. Figure 1-4 shows a typical crystal oscillator circuit for an AT-cut, parallel resonant crystal. Follow the crystal supplier's recommendations, as the crystal parameters determine the external component values required to provide reliable start-up and maximum stability. The load capacitance values used in the oscillator circuit design should include all stray layout capacitances. To minimize output distortion, mount the crystal and capacitors as close as possible to the pins.

MC68HC05P6

GENERAL DESCRIPTION

Use an AT-cut crystal and not an AT-strip crystal. The MCU may overdrive an AT-strip crystal.

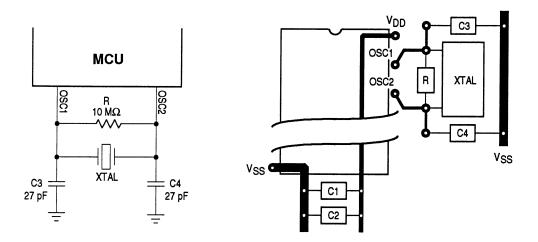


Figure 1-4. Crystal Connections

1.4.2.2 Ceramic Resonator

To reduce cost, use a ceramic resonator in place of the crystal. Use the circuit in Figure 1-5 for a ceramic resonator, and follow the resonator manufacturer's recommendations. The load capacitance values used in the oscillator circuit design should include all stray layout capacitances. To minimize output distortion, mount the resonator as close as possible to the pins.

NOTE

Because the frequency stability of ceramic resonators is not as high as that of crystal oscillators, using a ceramic resonator may degrade the performance of the analog-to-digital converter (ADC).

MOTOROLA 1-6 GENERAL DESCRIPTION

MC68HC05P6

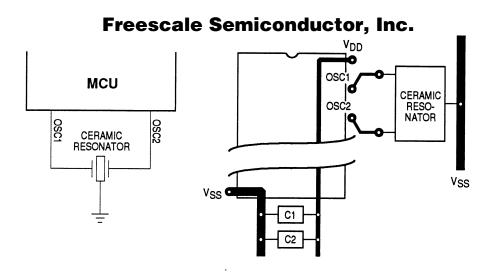


Figure 1-5. Ceramic Resonator Connections

1.4.2.3 RC Oscillator

For maximum cost reduction, the RC oscillator mask option allows the configuration shown in Figure 1-6 to drive the on-chip oscillator. The relationship between f_{OSC} and the external components is $f_{OSC} \approx 1 \div 2.28$ RC. The OSC2 signal is a square wave, and the signal on OSC1 is a triangular wave. The optimum frequency for the RC oscillator configuration is 2 MHz. Mount the RC components as close as possible to the pins for start-up stabilization and to minimize output distortion.

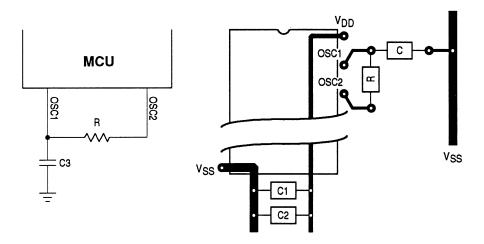


Figure 1-6. RC Oscillator Connections

MC68HC05P6

GENERAL DESCRIPTION

MOTOROLA 1-7

1.4.2.4 External Clock

With the RC oscillator mask option, an external clock from another CMOS-compatible device can drive the OSC1 input. Leave the OSC2 pin unconnected, as Figure 1-7 shows.

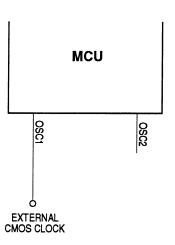


Figure 1-7. External Clock Connections

1.4.3 RESET

A logic zero on the RESET pin forces the MCU to a known start-up state. (See **5.1.2 External Reset** for more information.)

1.4.4 IRQ

The \overline{IRQ} pin has the following functions:

- Applying asynchronous external interrupt signals (See **4.1.2 External** Interrupt.)
- Applying V_{TST} to put the MCU in self-check mode (See SECTION 11 SELF-CHECK ROM.)

MOTOROLA 1-8 GENERAL DESCRIPTION

MC68HC05P6

1.4.5 PA7-PA0

Freescale Semiconductor, Inc.

PA7-PA0 are the pins of port A, a general-purpose bidirectional I/O port.

1.4.6 PB7/SCK

PB7/SCK is a general-purpose bidirectional port B I/O pin. When the serial I/O port (SIOP) is enabled, PB7/SCK is the serial clock input pin (slave mode) or the serial clock output pin (master mode).

1.4.7 PB6/SDI

PB6/SDI is a general-purpose bidirectional port B I/O pin. When the serial I/O port (SIOP) is enabled, PB6/SDI is the serial data input pin.

1.4.8 PB5/SDO

PB5/SDO is a general-purpose bidirectional port B I/O pin. When the serial I/O port (SIOP) is enabled, PB5/SDO is the serial data output pin.

1.4.9 PC7/V_{RH}

 $PC7/V_{RH}$ is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, $PC7/V_{RH}$ is the positive reference voltage pin for the ADC.

1.4.10 PC6/AN0

PC6/AN0 is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC6/AN0 is an analog input pin to the ADC.

1.4.11 PC5/AN1

PC5/AN1 is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC5/AN1 is an analog input pin to the ADC.

MC68HC05P6

GENERAL DESCRIPTION

1.4.12 PC4/AN2

PC4/AN2 is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC4/AN2 is an analog input pin to the ADC.

1.4.13 PC3/AN3

PC3/AN3 is a general-purpose bidirectional port C I/O pin. When the analog-to-digital converter (ADC) is enabled, PC3/AN3 is an analog input pin to the ADC.

1.4.14 PC2-PC0

PC2–PC0 are general-purpose bidirectional port C I/O pins.

1.4.15 PD7/TCAP

PD7/TCAP serves as both a general-purpose input-only port D I/O pin and as the input capture line for the capture/compare timer.

1.4.16 PD5

PD5 is a general-purpose bidirectional port D I/O pin.

1.4.17 TCMP

TCMP is the output pin for the output compare function of the capture/compare timer.

MOTOROLA 1-10 GENERAL DESCRIPTION

MC68HC05P6

SECTION 2 MEMORY

This section describes the organization of the on-chip memory.

2.1 Memory Map

The CPU can address 8 Kbytes of memory space. The ROM portion of memory holds the program instructions, fixed data, user-defined vectors, and interrupt service routines. The RAM portion of memory holds variable data. I/O registers are memory-mapped so that the CPU can access their locations in the same way that it accesses all other memory locations. Figure 2-1 is a memory map of the MCU.

2.2 Input/Output Section

The first 32 addresses of the memory space, \$0000-\$001F, are the I/O section. These are the addresses of the I/O control registers, status registers, and data registers. (See Figure 2-2.)

One I/O register shown in Figure 2-2 is located outside the 32-byte I/O section: the computer operating properly (COP) register is mapped at \$1FF0.

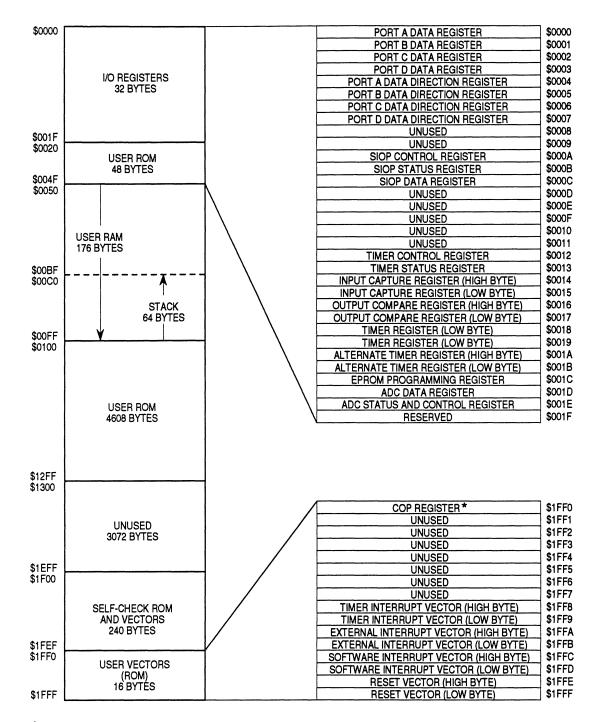
2.3 RAM

The 176 addresses from \$0050 to \$00FF are RAM locations. The CPU uses the top 64 RAM addresses, \$00CO-\$00FF, as the stack. Before processing an interrupt, the CPU uses five bytes of the stack to save the contents of the CPU registers. During a subroutine call, the CPU uses two stack bytes to store the return address. The stack pointer decrements during pushes and increments during pulls.

MC68HC05P6

MEMORY

Be careful when using nested subroutines or multiple interrupt levels. The CPU may overwrite data in the RAM during a subroutine or during the interrupt stacking operation.



* Writing zero to bit 0 of \$1FF0 clears the COP watchdog timer. Reading \$1FF0 returns user ROM data.

Figure 2-1. Memory Map

MOTOROLA 2-2

MEMORY

MC68HC05P6

For More Information On This Product, Go to: www.freescale.com

Freescale Semiconductor, Inc.

| Freescale | Semiconductor, | Inc. |
|-----------|----------------|------|
|-----------|----------------|------|

| \$0000 [| Bit 7 PA7 | 6 PA6 | 5 PA5 | 4 PA4 | 3 PA3 | 2 PA2 | 1 PA1 | Bit 0 PA0 | PORTA |
|----------------------|--------------|----------|-----------|------------|------------|----------|----------|---------------------------------------|----------------|
| \$0000 | | PB6 | PB5 | | | | | · · · · · · · · · · · · · · · · · · · | _ |
| - | | | | 0 | 0 | 0 | 0 | 0 | |
| \$0002 | PC7 | PC6 | PC5 | PC4 | PC3 | PC2 | PC1 | PC0 | |
| \$0003 | PD7 | 0 | PD5 | 1 | 0 | 0 | 0 | 0 | PORTD |
| \$0004 [| DDRA7 | DDRA6 | DDRA5 | DDRA4 | DDRA3 | DDRA2 | DDRA1 | DDRA0 | DDRA |
| \$0005 [| DDRB7 | DDRB6 | DDRB5 | 1 | 1 | 1 | 1 | 1 | DDRB |
| \$0006 | DDRC7 | DDRC6 | DDRC5 | DDRC4 | DDRC3 | DDRC2 | DDRC1 | DDRC0 | DDRC |
| \$0007 [| 0 | 0 | DDRD5 | 0 | 0 | 0 | 0 | 0 | DDRD |
| \$0008 [| | | | _ | | — | | | UNUSED |
| \$0009 [| | | | | | | | — | UNUSED |
| \$000A [| 0 | SPE | 0 | MSTR | 0 | 0 | 0 | 0 | SCR |
| \$000B [| SPIF | DCOL | 0 | 0 | 0 | 0 | 0 | 0 | SSR |
| \$000C [| Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 | SDR |
| \$000D [| | | | | | | | | RESERVED |
| \$000E [| | | | | | | | _ | UNUSED |
| \$000F [| | | | | | — | | | UNUSED |
| \$0010 [| | | |] | | | | | UNUSED |
| \$0011 [| | | — | — | — | | | | UNUSED |
| \$0012 [| ICIE | OCIE | TOIE | 0 | 0 | 0 | IEDG | OLVL | TCR |
| \$0013 [| ICF | OCF | TOF | 0 | 0 | 0 | 0 | 0 | TSR |
| \$0014 [| Bit 15 | 14 | 13 | 12 | 11 | 10 | 9 | Bit 8 | ICRH |
| \$0015 [| Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 | ICRL |
| \$0016 | Bit 15 | 14 | 13 | 12 | 11 | 10 | 9 | Bit 8 | OCRH |
| \$0017 [| Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 | OCRL |
| \$0018 [| Bit 15 | 14 | 13 | 12 | 11 | 10 | 9 | Bit 8 | TCRH |
| \$0019 [| Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 | TCRL |
| \$001A [| Bit 15 | 14 | 13 | 12 | 11 | 10 | 9 | Bit 8 | ACRH |
| \$001B [| Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 | ACRL |
| | | | | | | | | | |
| \$001C [| | | | | — | _ | | _ | UNUSED |
| \$001C [\$001D [| Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | — Bit 0 | UNUSED ADDR |
| - | | | 5 ADON | 4 0 | 3 0 | 2 CH2 | | | |
| \$001D | Bit 7 | 6 | | | | | | Bit 0 | ADDR |
| \$001D [\$001E [| Bit 7 | 6 | | | | | | Bit 0 | ADDR ADSCR |

Figure 2-2. I/O Registers

2.4 ROM

The ROM is located in three areas of the memory map:

- Addresses \$0020-\$004F contain 48 bytes of page zero ROM.
- Addresses \$0100-\$12FF contain 4608 bytes of ROM.
- Addresses \$1FF0-\$1FFF contain 16 bytes of ROM reserved for vectors.

2.5 Self-Check ROM

Addresses \$1F00-\$1FEF contain the self-check ROM. When activated, the self-check program performs a series of MCU functional tests. (See **SECTION 11 SELF-CHECK ROM**.)



MEMORY

MC68HC05P6

SECTION 3 CENTRAL PROCESSOR UNIT

This section describes the CPU registers.

3.1 CPU Registers

Figure 3-1 shows the five CPU registers. CPU registers are not part of the memory map.

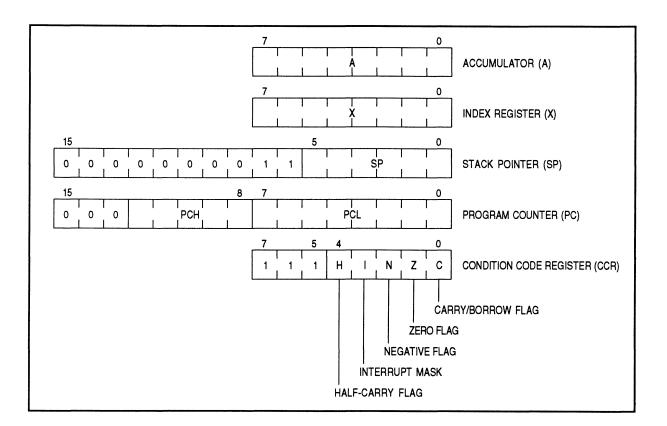
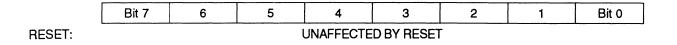


Figure 3-1. Programming Model

CENTRAL PROCESSOR UNIT

3.1.1 Accumulator

The accumulator is a general-purpose 8-bit register. The CPU uses the accumulator to hold operands and results of arithmetic and nonarithmetic operations.





3.1.2 Index Register

In the indexed addressing modes, the CPU uses the byte in the index register to determine the conditional address of the operand. (See **12.1 Addressing Modes**.)

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|-------|---|---|-----------|------------|---|---|-------|
| RESET: | | | l | UNAFFECTE | D BY RESET | Г | | |

Figure 3-3. Index Register

The 8-bit index register can also serve as a temporary data storage location.

MOTOROLA 3-2 CENTRAL PROCESSOR UNIT

MC68HC05P6

3.1.3 Stack Pointer

The stack pointer is a 16-bit register that contains the address of the next location on the stack. During a reset or after the reset stack pointer (RSP) instruction, the stack pointer is preset to \$00FF. The address in the stack pointer decrements as data is pushed onto the stack and increments as data is pulled from the stack.

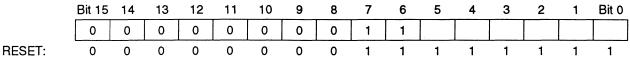


Figure 3-4. Stack Pointer

The ten most significant bits of the stack pointer are permanently fixed at 000000011, so the stack pointer produces addresses from \$00C0 to \$00FF. If subroutines and interrupts use more than 64 stack locations, the stack pointer wraps around to address \$00FF and begins writing over the previously stored data. A subroutine uses two stack locations; an interrupt uses five locations.

MC68HC05P6

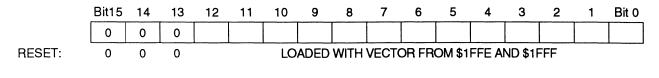
CENTRAL PROCESSOR UNIT

MOTOROLA 3-3

3.1.4 Program Counter

The program counter is a 16-bit register that contains the address of the next instruction or operand to be fetched. The three most significant bits of the program counter are ignored internally and appear as 000.

Normally, the address in the program counter automatically increments to the next sequential memory location every time an instruction or operand is fetched. Jump, branch, and interrupt operations load the program counter with an address other than that of the next sequential location.





3.1.5 Condition Code Register

The condition code register is an 8-bit register whose three most significant bits are permanently fixed at 111. The condition code register contains the interrupt mask and four flags that indicate the results of the instruction just executed. The following paragraphs describe the functions of the condition code register.

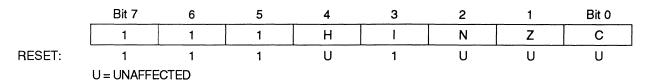


Figure 3-6. Condition Code Register

CENTRAL PROCESSOR UNIT

MC68HC05P6

3.1.5.1 Half-Carry Flag (H)

The CPU sets the half-carry flag when a carry occurs between bits 3 and 4 of the accumulator during an ADD or ADC operation. The half-carry flag is required for binary-coded decimal (BCD) arithmetic operations.

3.1.5.2 Interrupt Mask (I)

Setting the interrupt mask disables interrupts. If an interrupt request occurs while the interrupt mask is logic zero, the CPU saves the CPU registers on the stack, sets the interrupt mask, and then fetches the interrupt vector. If an interrupt request occurs while the interrupt mask is set, the interrupt request is latched. Normally, the CPU processes the latched interrupt as soon as the interrupt mask is cleared again.

A return from interrupt (RTI) instruction pulls the CPU registers from the stack, restoring the interrupt mask to its cleared state. After any reset, the interrupt mask is set and can be cleared only by a software instruction.

3.1.5.3 Negative Flag (N)

The CPU sets the negative flag when an arithmetic operation, logical operation, or data manipulation produces a negative result.

3.1.5.4 Zero Flag (Z)

The CPU sets the zero flag when an arithmetic operation, logical operation, or data manipulation produces a result of \$00.

3.1.5.5 Carry/Borrow Flag (C)

The CPU sets the carry/borrow flag when an addition operation produces a carry out of bit 7 of the accumulator or when a subtraction operation requires a borrow. Some logical operations and data manipulation instructions also clear or set the carry/borrow flag.

MC68HC05P6

CENTRAL PROCESSOR UNIT

Freescale Semiconductor, Inc. 3.2 Arithmetic/Logic Unit (ALU)

The ALU performs the arithmetic and logical operations defined by the instruction set.

The binary arithmetic circuits decode instructions and set up the ALU for the selected operation. Most binary arithmetic is based on the addition algorithm, carrying out subtraction as negative addition. Multiplication is not performed as a discrete operation but as a chain of addition and shift operations within the ALU. The multiply instruction (MUL) requires 11 internal processor cycles to complete this chain of operations.

MOTOROLA 3-6 CENTRAL PROCESSOR UNIT

MC68HC05P6

SECTION 4 INTERRUPTS

This section describes how interrupts temporarily change the normal processing sequence.

4.1 Interrupt Sources

The following sources can generate interrupt requests:

- SWI instruction
- IRQ pin
- Capture/compare timer

An interrupt temporarily stops normal program execution to process a particular event. An interrupt does not stop the execution of the instruction in progress, but takes effect when the current instruction completes its execution. Interrupt processing automatically saves the CPU registers on the stack and loads the program counter with a user-defined interrupt vector address.

4.1.1 Software Interrupt

The software interrupt (SWI) instruction causes a nonmaskable interrupt.

4.1.2 External Interrupt

An interrupt signal on the IRQ pin latches an external interrupt request. When the CPU completes its current instruction, it tests the IRQ latch. If the IRQ latch is set, the CPU then tests the I bit in the condition code register. If the I bit is clear, the CPU then begins the interrupt sequence. The CPU clears the IRQ latch while it fetches the interrupt vector, so another external interrupt request can be latched during the interrupt service routine. As soon as the I bit is cleared during the return from interrupt, the CPU can recognize the new interrupt request.

MC68HC05P6

INTERRUPTS

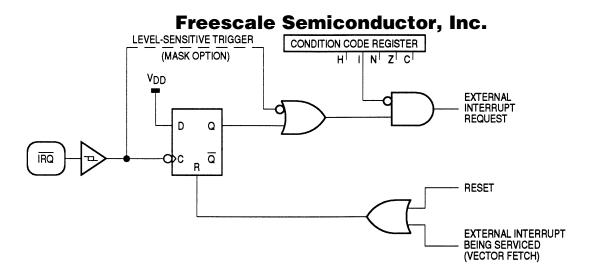


Figure 4-1. External Interrupt Logic

Interrupt triggering sensitivity of the IRQ pin is a mask option. The IRQ pin can be negative edge-triggered or negative edge- and low-level-triggered. The low-level-sensitive triggering option allows the wired-OR use of multiple external interrupt sources. An external interrupt request is latched as long as any source is holding the IRQ pin low.

MOTOROLA 4-2 INTERRUPTS

MC68HC05P6

4.1.3 Timer Interrupts

The capture/compare timer can generate the following interrupts:

- Input capture interrupt
- Output compare interrupt
- Timer overflow interrupt

Setting the I bit in the condition code register disables timer interrupts.

4.1.3.1 Input Capture Interrupt

An input capture interrupt request occurs if the input capture flag, ICF, becomes set while the input capture interrupt enable bit, ICIE, is also set. ICF is in the timer status register, and ICIE is in the timer control register. (See **SECTION 8 CAPTURE/COMPARE TIMER**.)

4.1.3.2 Output Compare Interrupt

An output compare interrupt request occurs if the output compare flag, OCF, becomes set while the output compare interrupt enable bit, OCIE, is also set. OCF is in the timer status register, and OCIE is in the timer control register. (See SECTION 8 CAPTURE/COMPARE TIMER.)

4.1.3.3 Timer Overflow Interrupt

A timer overflow interrupt request occurs if the timer overflow flag, TOF, becomes set while the timer overflow interrupt enable bit, TOIE, is also set. TOF is in the timer status register, and TOIE is in the timer control register. (See **SECTION 8 CAPTURE/COMPARE TIMER**.)

INTERRUPTS

4.2 Interrupt Processing

The CPU begins servicing an interrupt by taking the following actions:

- Stores the CPU registers on the stack in the order shown in Figure 4-2
- Sets the I bit in the condition code register to prevent further interrupts
- Loads the program counter with the contents of the appropriate interrupt vector locations:
 - \$1FFC and \$1FFD (software interrupt vector)
 - \$1FFA and \$1FFB (external interrupt vector)
 - \$1FF8 and \$1FF9 (timer interrupt vector)

The return from interrupt (RTI) instruction causes the CPU to recover the CPU registers from the stack as shown in Figure 4-2.

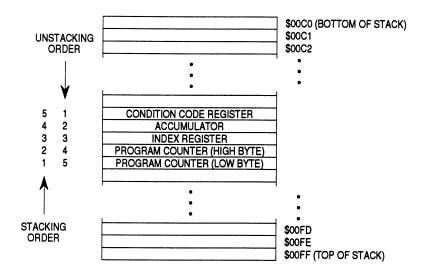


Figure 4-2. Interrupt Stacking Order

MOTOROLA 4-4

INTERRUPTS

MC68HC05P6

Freescale Semiconductor, Inc. Table 4-1 summarizes the reset and interrupt sources and vector assignments.

| | | | - | | |
|--------------------------------|--|----------------------------------|----------------|---------------------------------|-------------------|
| Function | Source | Local Mask | Global Mask | Priority (1 = Highest) | Vector Address |
| Reset | Power-On RESET Pin COP Watchdog* | None | None | 1 1 1 | \$1FFE-\$1FFF |
| Software Interrupt (SWI) | User Code | None | None | Same Priority As Instruction | \$1FFC-\$1FFD |
| External Interrupt | IRQ Pin | None | l Bit | 2 | \$1FFA-\$1FFB |
| Timer Interrupts | ICF Bit OCF Bit TOF Bit | ICIE Bit OCIE Bit TOIE Bit | I Bit | 3 | \$1FF8-\$1FF9 |

Table 4-1. Reset/Interrupt Vector Addresses

*The COP watchdog is a mask option.

MC68HC05P6

INTERRUPTS

MOTOROLA 4-5

Freescale Semiconductor, Inc. Figure 4-3 shows the sequence of events caused by an interrupt.

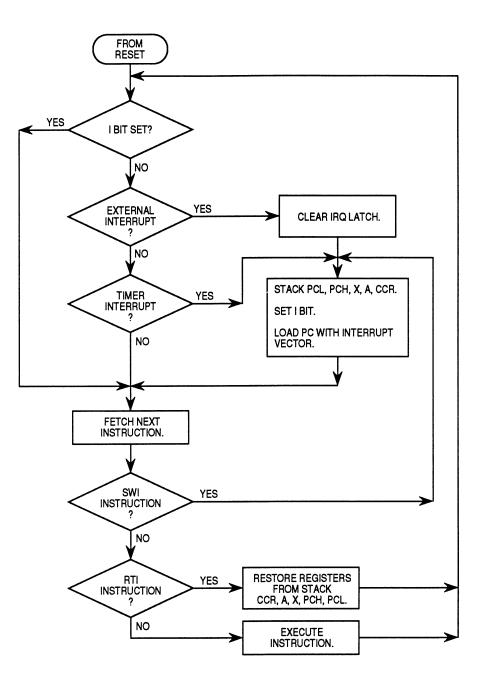


Figure 4-3. Interrupt Flowchart

INTERRUPTS

MC68HC05P6

SECTION 5 RESETS

This section describes the three reset sources and how they initialize the MCU.

5.1 Reset Sources

The following sources can generate resets:

- Power-on reset (POR) circuit
- RESET pin
- COP watchdog

A reset immediately stops the execution of the instruction in progress, initializes certain control bits, and loads the program counter with a user-defined reset vector address. Figure 5-1 is a block diagram of the reset sources.

5.1.1 Power-On Reset

A positive transition on the V_{DD} pin generates a power-on reset. The power-on reset is strictly for power-up conditions and cannot be used to detect drops in power supply voltage.

A 4064 t_{CYC} (internal clock cycle) delay after the oscillator becomes active allows the clock generator to stabilize. If the RESET pin is at logic zero at the end of 4064 t_{CYC} , the MCU remains in the reset condition until the signal on the RESET pin goes to logic one.

5.1.2 External Reset

A logic zero applied to the RESET pin for one and one-half t_{CYC} generates an external reset. A Schmitt trigger senses the logic level at the RESET pin. (See Figure 5-1.)

MC68HC05P6

RESETS

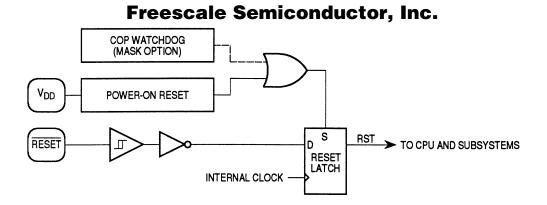
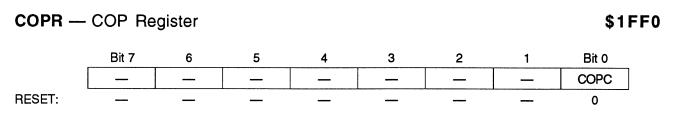


Figure 5-1. Reset Sources

5.1.3 Computer Operating Properly (COP) Watchdog Reset

A timeout of the COP watchdog generates a COP reset. The COP watchdog is part of a software error detection system and must be cleared periodically to start a new timeout period. To clear the COP watchdog and prevent a COP reset, write a logic zero to bit 0 (COPC) of the COP register at location \$1FF0. The COP register, shown in Figure 5-2, is a write-only register that returns the contents of a ROM location when read.

The COP watchdog function is a mask option.





COPC — COP Clear

COPC is a write-only bit. Periodically writing a logic zero to COPC prevents the COP watchdog from resetting the MCU.

RESETS

MC68HC05P6

5.2 Reset States

Freescale Semiconductor, Inc.

The following paragraphs describe how resets initialize the MCU.

5.2.1 CPU

A reset has the following effects on the CPU:

- Loads the stack pointer with \$FF
- Sets the I bit in the condition code register, inhibiting interrupts
- Loads the program counter with the user-defined reset vector from locations \$1FFE and \$1FFF
- Clears the stop latch, enabling the CPU clock
- Clears the wait latch, waking the CPU from the wait mode

5.2.2 I/O Port Registers

A reset has the following effects on I/O port registers:

- Clears data direction registers A, B, C, and D so that all I/O port pins are inputs (PD7/TCAP remains an input-only pin.)
- Has no effect on port A, port B, port C, or port D data registers

5.2.3 Capture/Compare Timer

A reset has the following effects on the capture/compare timer:

- Loads the timer counter with \$FFFC
- Clears the timer control register, except for the IEDG bit, with the following results:

MC68HC05P6

RESETS

- Clears the OCIE bit, inhibiting output compare interrupts
- Clears the TOIE bit, inhibiting timer overflow interrupts
- Clears OLVL, the output compare bit
- Clears the TCMP pin
- Has no effect on the ICF, OCF, and TOF flags in the timer status register ۲

5.2.4 Serial I/O Port (SIOP)

A reset clears the SIOP control and status registers and produces the following results:

- Clears the SPE bit, disabling the SIOP
- Clears the MSTR bit, configuring the disabled SIOP for slave mode operation
- Clears the SPIF and DCOL flags

5.2.5 COP Watchdog

A reset clears the COP watchdog timer.

5.2.6 Analog-to-Digital Converter (ADC)

A reset clears the ADC status and control register and produces the following results:

- Clears the ADON bit, disabling the ADC ۲
- Clears the CCF flag •
- Clears the ADRC bit, configuring the disabled ADC for operation at ٠ internal clock frequency
- Clears bits CH2–CH0, selecting channel 0 as the analog input •

MOTOROLA 5-4

RESETS

MC68HC05P6

SECTION 6 LOW POWER MODES

This section describes the four low-power modes:

- Stop mode
- Wait mode
- Halt mode (mask option)
- Data-retention mode

6.1 Stop Mode

The STOP instruction puts the MCU in its lowest power-consumption mode and has the following effects on the MCU:

- Stops the internal oscillator, the CPU clock, and the internal clock, turning off the capture/compare timer, the COP watchdog, the SIOP, and the ADC
- Clears the I bit in the condition code register, enabling external interrupts
- Clears the ICF, OCF, and TOF interrupt flags in the timer status register, removing any pending timer interrupts
- Clears the ICIE, OCIE, and TOIE bits in the timer control register, disabling further timer interrupts

The STOP instruction does not affect any other registers or any I/O lines.

MC68HC05P6

LOW POWER MODES

The following events bring the MCU out of stop mode:

- External interrupt A high-to-low transition on the IRQ pin loads the program counter with the contents of locations \$1FFA and \$1FFB.
- External reset A logic zero on the RESET pin resets the MCU and loads the program counter with the contents of locations \$1FFE and \$1FFF.

When the MCU exits stop mode, processing resumes after a stabilization delay of 4064 oscillator cycles.

If an external interrupt brings the MCU out of stop mode after an active edge occurred on the PD7/TCAP pin during stop mode, the ICF flag becomes set. An external interrupt also latches the value in the timer registers into the input capture registers.

If an external reset brings the MCU out of stop mode after an active edge occurred on the PD7/TCAP pin during stop mode, the ICF flag does not become set. An external reset has no effect on the input capture registers.

6.2 Wait Mode

The WAIT instruction puts the MCU in an intermediate power-consumption mode and has the following effects on the MCU:

- Clears the I bit in the condition code register, enabling interrupts.
- Stops the CPU clock, but allows the internal oscillator and internal clock to continue to run.

The WAIT instruction does not affect any other registers or any I/O lines.

The following events restart the CPU clock and bring the MCU out of wait mode:

- External interrupt A high-to-low transition on the IRQ pin loads the program counter with the contents of locations \$1FFA and \$1FFB.
- Timer interrupt Input capture, output compare, and timer overflow interrupts load the program counter with the contents of locations \$1FF8 and \$1FF9.

LOW POWER MODES

MC68HC05P6

- COP watchdog reset A timeout of the COP watchdog resets the MCU and loads the program counter with the contents of locations \$1FFE and \$1FFF. Software can enable timer interrupts so that the MCU can periodically exit wait mode to reset the COP watchdog.
- External reset A logic zero on the RESET pin resets the MCU and loads the program counter with the contents of locations \$1FFE and \$1FFF.

6.3 Halt Mode

If the mask option to disable the STOP instruction is selected, a STOP instruction puts the MCU in halt mode. The halt mode is identical to the wait mode, except that a recovery delay of 1–4064 internal clock cycles occurs when the MCU exits the halt mode. If the mask option to disable the STOP instruction is selected, the COP watchdog cannot be inadvertently turned off by a STOP instruction.

Figure 6-1 shows the sequence of events in stop, wait, and halt modes.

6.4 Data-Retention Mode

In data-retention mode, the MCU retains RAM contents and CPU register contents at V_{DD} voltages as low as 2.0 Vdc. The data-retention feature allows the MCU to remain in a low power-consumption state during which it retains data, but the CPU cannot execute instructions.

To put the MCU in data-retention mode:

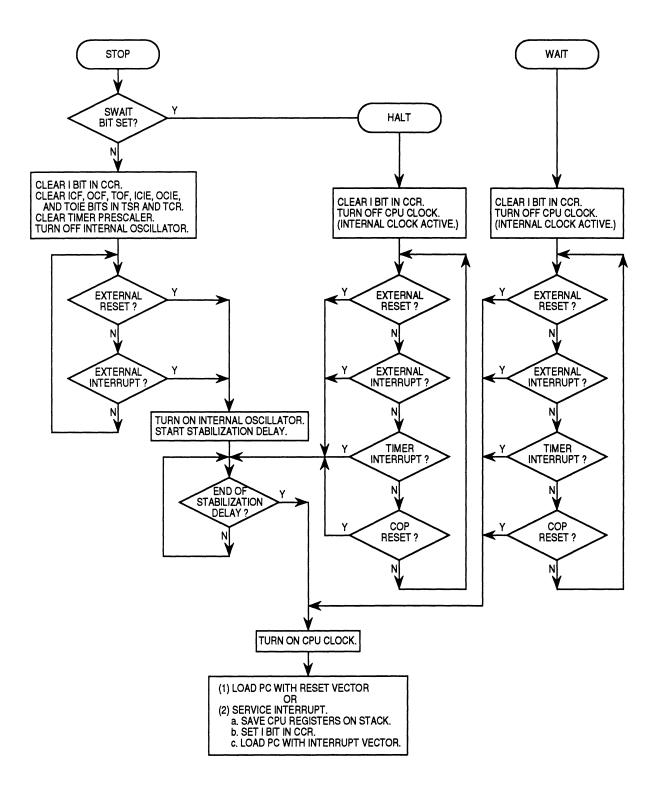
- 1. Drive the $\overline{\text{RESET}}$ pin to logic zero.
- 2. Lower the V_{DD} voltage. The RESET pin must remain low continuously during data-retention mode.

To take the MCU out of data-retention mode:

- 1. Return V_{DD} to normal operating voltage.
- 2. Return the $\overline{\text{RESET}}$ pin to logic one.

MC68HC05P6

LOW POWER MODES





6-4

LOW POWER MODES

MC68HC05P6

SECTION 7 PARALLEL I/O

This section describes the four bidirectional I/O ports.

7.1 I/O Port Function

Twenty bidirectional I/O pins and one input-only pin form four parallel I/O ports. The 20 bidirectional I/O pins are programmable as inputs or outputs through the four data direction registers.

NOTE

Connect any unused inputs and I/O pins to an appropriate logic level, either V_{DD} or V_{SS} . Although the I/O ports do not require termination for proper operation, termination reduces excess current consumption and the possibility of electrostatic damage.

7.2 Port A

Port A is an 8-bit general-purpose bidirectional I/O port.

7.2.1 Port A Data Register (PORTA)

The port A data register, shown in Figure 7-1, contains a data latch for each of the eight port A pins.

MC68HC05P6

PARALLEL I/O

MOTOROLA 7-1

PORTA — Port A Data Register

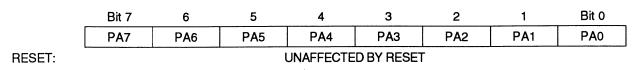


Figure 7-1. Port A Data Register (PORTA)

PA7-PA0 --- Port A Data Bits

These read/write bits are software-programmable. Data direction of each bit is under the control of the corresponding bit in data direction register A. Resets have no effect on port A data.

7.2.2 Data Direction Register A (DDRA)

Data direction register A, shown in Figure 7-2, determines whether each port A pin is an input or an output. Writing a logic one to a DDRA bit enables the output buffer for the corresponding port A pin; a logic zero disables the output buffer.

DDRA — Data Direction Register A

\$0004

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|-------|-------|-------|-------|-------|-------|-------|-------|
| | DDRA7 | DDRA6 | DDRA5 | DDRA4 | DDRA3 | DDRA2 | DDRA1 | DDRA0 |
| RESET: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 7-2. Data Direction Register A (DDRA)

DDRA7-DDRA0 - Port A Data Direction Bits

These read/write bits control port A data direction. A reset clears all DDRA bits, configuring all port A pins as inputs.

1 = Corresponding port A pin configured as output

0 = Corresponding port A pin configured as input

For More Information On This Product, Go to: www.freescale.com

ы.

Avoid glitches on port A pins by writing to the port A data register before changing data direction register A bits from 0 to 1.

Figure 7-3 shows the port A I/O logic.

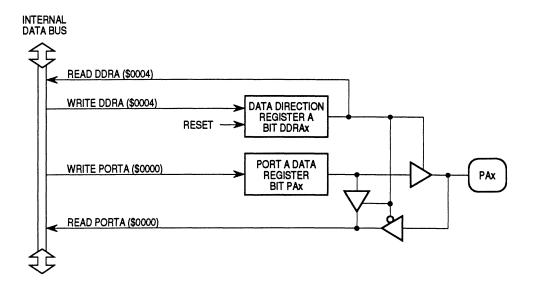


Figure 7-3. Port A I/O Circuit

When a port A pin is programmed as an output, reading the port bit reads the value of the data latch and not the voltage on the pin. When a port A pin is programmed as an input, reading the port bit reads the voltage level on the pin. The data register can always be written, regardless of the state of its DDRA bit. Table 7-1 summarizes the operations of the port A pins.

MC68HC05P6

PARALLEL I/O

MOTOROLA 7-3

Freescale Semiconductor, Inc. Table 7-1. Port A Pin Functions

| DDRA Bit | PORTA Bit | I/O Pin Mode | Accesses to DDRA | Accesses to PORTA | |
|----------|-----------|--------------|---------------------|----------------------|--------|
| | | | Read/Write | Read | Write |
| 0 | X | Input, Hi-Z | DDRA7-0 | Pin | NOTE 2 |
| 1 | X | Output | DDRA7-0 | PA7–0 | PA70 |

NOTES:

1. X = don't care

2. Writing affects data register, but does not affect input

3. Hi-Z = high impedance

7.3 Port B

Port B is a 3-bit general-purpose bidirectional I/O port that shares its pins with the serial I/O port (SIOP) subsystem. Port B is available for general-purpose I/O functions when the SIOP is disabled. While the SIOP is enabled and a SIOP data transfer is in progress, writing to the port B data register or to bits DDRB7–DDRB5 of data direction register B can corrupt the SIOP data. (See 9.2.1 SIOP Control Register (SCR).)

7.3.1 Port B Data Register (PORTB)

The port B data register, shown in Figure 7-4, contains a data latch for each of the three port B pins.

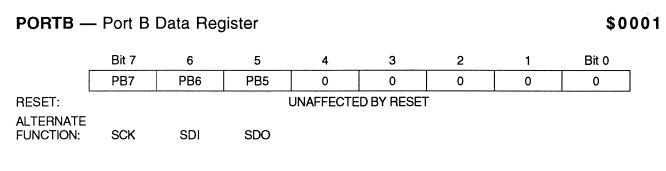


Figure 7-4. Port B Data Register (PORTB)

PB7-PB5 - Port B Data Bits

These read/write bits are software-programmable. Data direction of each bit is under the control of the corresponding bit in data direction register B. Resets have no effect on port B data.

Bits 4-0 - Not used

Bits 4–0 always read as logic zeros. Writes to these bits have no effect.

MOTOROLA

7-4

PARALLEL I/O

MC68HC05P6

Freescale Semiconductor, Inc. 7.3.2 Data Direction Register B (DDRB)

Data direction register B determines whether each port B pin is an input or an output. (See Figure 7-5.) Writing a logic one to a DDRB bit enables the output buffer for the corresponding port B pin; a logic zero disables the output buffer.





| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|-------|-------|-------|---|---|---|---|-------|
| | DDRB7 | DDRB6 | DDRB5 | 0 | 0 | 0 | 0 | 0 |
| RESET: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 7-5. Data Direction Register B (DDRB)

DDRB7-DDRB5 - Port B Data Direction Bits

These read/write bits control port B data direction. A reset clears DDRB7–DDRB5, configuring pins PB7–PB5 as inputs.

1 = Corresponding port B pin configured as output

0 = Corresponding port B pin configured as input

Bits 4-0 - Not used

Bits 4–0 always read as logic zeros. Writes to these bits have no effect.

NOTE

Avoid glitches on port B pins by writing to the port B data register before changing data direction register B bits from 0 to 1.

PARALLEL I/O

Figure 7-6 shows the port B I/O logic.

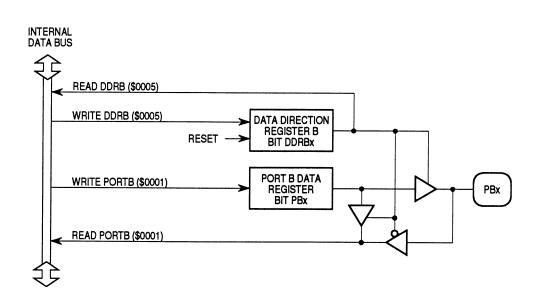


Figure 7-6. Port B I/O Circuit

When a port B pin is programmed as an output, reading the port bit actually reads the value of the data latch and not the voltage on the pin. When a port B pin is programmed as an input, reading the port bit reads the voltage level on the pin. The data latch can always be written, regardless of the state of its DDRB bit. Table 7-2 summarizes the operation of the port B pins.

| Table | 7-2. | Port | В | Pin | Functions |
|-------|------|------|---|-----|-----------|
|-------|------|------|---|-----|-----------|

| DDRB Bit | PORTB Bit | I/O Pin Mode | Accesses to DDRB | Accesses to PORTB | |
|----------|-----------|--------------|---------------------|----------------------|--------|
| | | | Read/Write | Read | Write |
| 0 | X | Input, Hi-Z | DDRB7-5 | Pin | NOTE 2 |
| 1 | X | Output | DDRB7-5 | PB7–5 | PB7–5 |

NOTES:

1. X = don't care

2. Writing affects data register, but does not affect input

3. Hi-Z = high impedance

reescale Semiconductor, Inc.

PARALLEL I/O

7.4 Port C

Port C is an 8-bit general-purpose bidirectional I/O port that shares five of its pins with the analog-to-digital converter (ADC) subsystem. The five shared pins are available for general-purpose I/O functions when the ADC is disabled. While the ADC is enabled, writing to bits PC7–PC5 of the port C data register or to bits DDRC7–DDRC5 of data direction register C can produce unpredictable ADC results. (See **10.2.1 ADC Status and Control Register (ADSCR)**.)

7.4.1 Port C Data Register (PORTC)

The port C data register, shown in Figure 7-7, contains a data latch for each of the eight port C pins.

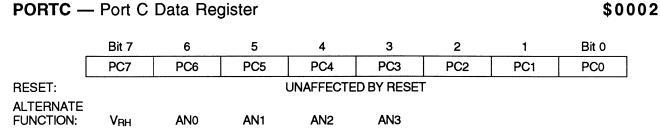


Figure 7-7. Port C Data Register (PORTC)

PC7-PC3 - Port C Data Bits

These read/write bits are software-programmable. Data direction of each bit is under the control of the corresponding bit in data direction register C. Resets have no effect on port C data.

PARALLEL I/O

Freescale Semiconductor, Inc. 7.4.2 Data Direction Register C (DDRC)

Data direction register C determines whether each port C pin is an input or an output. (See Figure 7-8.) Writing a logic one to a DDRC bit enables the output buffer for the corresponding port C pin; a logic zero disables the output buffer.

DDRC — Data Direction Register C

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|-------|-------|-------|-------|-------|-------|-------|-------|
| | DDRC7 | DDRC6 | DDRC5 | DDRC4 | DDRC3 | DDRC2 | DDRC1 | DDRC0 |
| RESET: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

Figure 7-8. Data Direction Register C (DDRC)

DDRC7-DDRC0 - Port C Data Direction Bits

These read/write bits control port C data direction. A reset clears all DDRC bits, configuring all port C pins as inputs.

1 = Corresponding port C pin configured as output

0 = Corresponding port C pin configured as input

NOTE

Avoid glitches on port C pins by writing to the port C data register before changing data direction register C bits from 0 to 1.

MOTOROLA 7-8 PARALLEL I/O

MC68HC05P6

\$0006

Figure 7-9 shows the port C I/O logic.

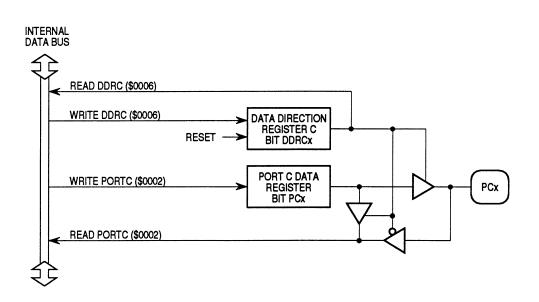


Figure 7-9. Port C I/O Circuit

When a port C pin is programmed as an output, reading the port bit actually reads the value of the data latch and not the voltage on the pin. When a port C pin is programmed as an input, reading the port bit reads the voltage level on the pin. The data register can always be written, regardless of the state of its DDRC bit. Table 7-3 summarizes the operation of the port C pins.

| DDRC Bit | PORTC Bit | I/O Pin Mode | Accesses to DDRC | Accesses to PORTC | |
|----------|-----------|--------------|---------------------|----------------------|--------|
| | | | Read/Write | Read | Write |
| 0 | X | Input, Hi-Z | DDRC7-0 | Pin | NOTE 2 |
| 1 | X | Output | DDRC7-0 | PC7-0 | PC7-0 |

NOTES:

1. X = don't care

2. Writing affects data register, but does not affect input

3. Hi-Z = high impedance

PARALLEL I/O

7.5 Port D

Freescale Semiconductor, Inc.

Port D is a 2-bit general-purpose I/O port with one bidirectional pin, PD5, and one input-only pin, PD7/TCAP. Port D shares pin PD7/TCAP with the capture/compare timer. PD7/TCAP is always available for general-purpose I/O functions, and the state of the pin can be read from the port D data register at any time.

7.5.1 Port D Data Register (PORTD)

The port D data register, shown in Figure 7-10, contains a data latch for each of the two port D pins.





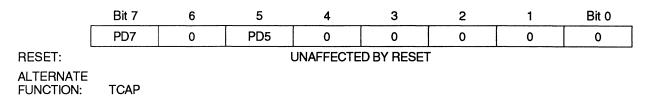


Figure 7-10. Port D Data Register (PORTD)

PD7 — Port D Data Bit 7

This read/write bit is software-programmable. The PD7/TCAP pin can be a general-purpose input even when the timer is using it as the input capture pin. Resets have no effect on PD7.

PD5 — Port D Data Bit 5

This read/write bit is software-programmable. Data direction of PD5 is under the control of bit DDRD5 in data direction register D. Resets have no effect on PD5.

Bit 6 and bits 4-0 - Not used

Bit 6 and bits 4–0 always read as logic zeros. Writes to these bits have no effect.

Semiconductor, Inc.

eescale

LL.

MOTOROLA 7-10 PARALLEL I/O

MC68HC05P6

Freescale Semiconductor, Inc. 7.5.2 Data Direction Register D (DDRD)

Bit DDRD5 in data direction register D, shown in Figure 7-11, determines whether pin PD5 is an input or an output. Writing a logic one to bit DDRD5 enables the output buffer for pin PD5; a logic zero disables the output buffer.

DDRD — Data Direction Register D



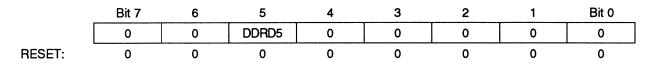


Figure 7-11. Data Direction Register D (DDRD)

DDRD5 — PD5 Data Direction Bit

This read/write bit controls pin PD5 data direction. A reset clears DDRD5, configuring pin PD5 as an input.

1 = Pin PD5 configured as output

0 = Pin PD5 configured as input

Bits 7-6 and bits 4-0 - Not used

Bits 7–6 and 4–0 always read as logic zeros. Writes to these bits have no effect.

NOTE

Avoid glitches on PD5 by writing to PD5 before changing DDRD5 from 0 to 1.

MC68HC05P6

PARALLEL I/O

Figure 7-12 shows the port D I/O logic.

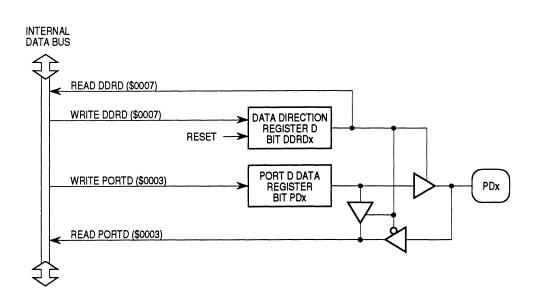


Figure 7-12. Port D I/O Circuit

When pin PD5 is programmed as an output, reading the port bit actually reads the value of the data latch and not the voltage on the pin. When pin PD5 is programmed as an input, reading bit PD5 reads the voltage level on the pin. Bit PD5 can always be written, regardless of the state of bit DDRD5 in data direction register D. Table 7-4 summarizes the operation of the port D pins.

| Table | 7-4. | Port | D | Pin | Functions |
|-------|------|------|---|-----|-----------|
|-------|------|------|---|-----|-----------|

| DDRD Bit | PORTD Bit | I/O Pin Mode | Accesses to DDRD | Accesses to PORTD | |
|----------|-----------|--------------|---------------------|----------------------|--------|
| | | | Read/Write | Read | Write |
| 0 | X | Input, hi-Z | DDRD5 | Pin | NOTE 2 |
| 1 | X | Output | DDRD5 | PD5 | PD5 |

NOTES:

1. X = don't care.

2. Writing affects data register, but does not affect input.



This section describes the operation of the 16-bit capture/compare timer. Figure 8-1 shows the organization of the capture/compare timer subsystem.

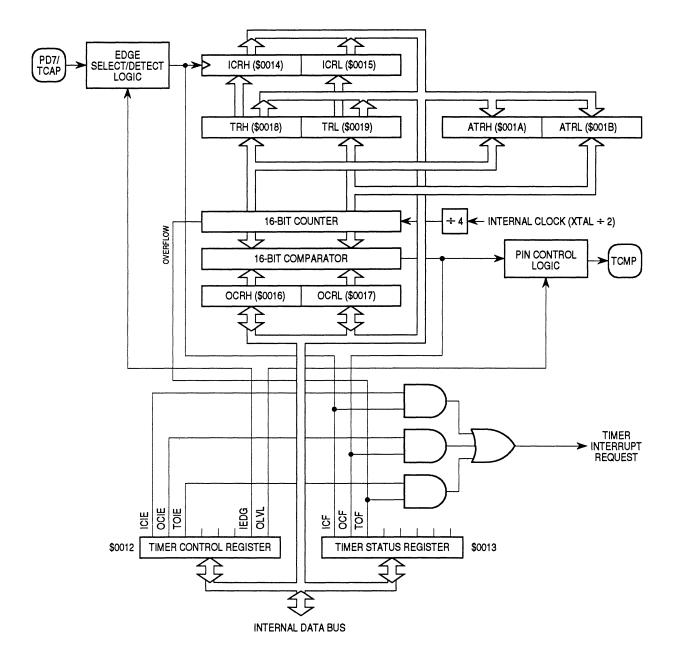


Figure 8-1. Timer Block Diagram

MC68HC05P6

CAPTURE/COMPARE TIMER

MOTOROLA 8-1

8.1 Timer Operation

The core of the capture/compare timer is a 16-bit free-running counter. The counter is the timing reference for the input capture and output compare functions. The input capture and output compare functions provide a means to latch the times at which external events occur, to measure input waveforms, and to generate output waveforms and timing delays. Software can read the value in the 16-bit free-running counter at any time without affecting the counter sequence.

Because of the 16-bit timer architecture, the I/O registers for the input capture and output compare functions are pairs of 8-bit registers.

Because the counter is 16 bits long and preceded by a fixed divide-by-four prescaler, the counter rolls over every 262,144 internal clock cycles. Timer resolution with a 4 MHz crystal is $2 \mu s$.

8.1.1 Input Capture

The input capture function is a means to record the time at which an external event occurs. When the input capture circuitry detects an active edge on the PD7/TCAP pin, it latches the contents of the timer registers into the input capture registers. The polarity of the active edge is a mask option.

Latching values into the input capture registers at successive edges of the same polarity measures the period of the input signal on the PD7/TCAP pin. Latching the counter values at successive edges of opposite polarity measures the pulse width of the signal. Figure 8-2 shows the logic of the input capture function.

CAPTURE/COMPARE TIMER

MC68HC05P6

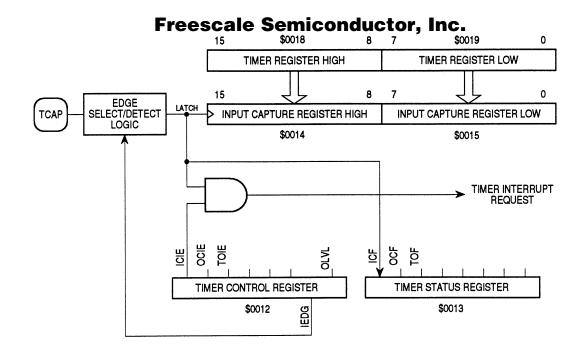


Figure 8-2. Input Capture Operation

8.1.2 Output Compare

The output compare function is a means of generating an output signal when the 16-bit counter reaches a selected value. Software writes the selected value into the output compare registers. On every fourth internal clock cycle the output compare circuitry compares the value of the counter to the value written in the output compare registers. When a match occurs, the timer transfers the programmable output level bit (OLVL) from the timer control register to the TCMP pin.

Software can use the output compare register to measure time periods, to generate timing delays, or to generate a pulse of specific duration or a pulse train of specific frequency and duty cycle on the TCMP pin. Figure 8-3 shows the logic of the output compare function.

MC68HC05P6

CAPTURE/COMPARE TIMER

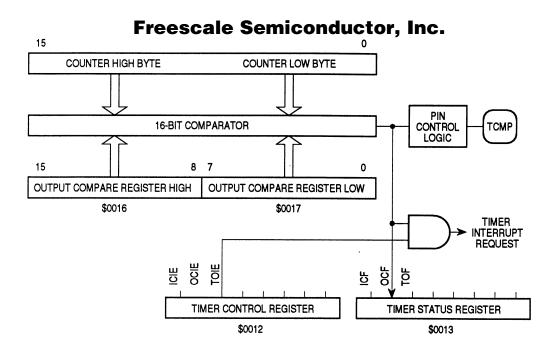


Figure 8-3. Output Compare Operation

8.2 Timer I/O Registers

The following registers control and monitor the operation of the timer:

- Timer control register (TCR)
- Timer status register (TSR)
- Timer registers (TRH and TRL)
- Alternate timer registers (ATRH and ATRL)
- Input capture registers (ICRH and ICRL)
- Output compare registers (OCRH and OCRL)

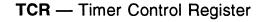
MOTOROLA 8-4 CAPTURE/COMPARE TIMER

MC68HC05P6

Freescale Semiconductor, Inc. 8.2.1 Timer Control Register (TCR)

The timer control register, shown in Figure 8-4, performs the following functions:

- Enables input capture interrupts
- Enables output compare interrupts
- Enables timer overflow interrupts
- Controls the active edge polarity of the TCAP signal
- Controls the active level of the TCMP output



\$0012

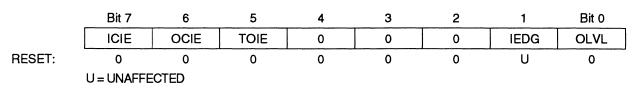


Figure 8-4. Timer Control Register (TCR)

ICIE — Input Capture Interrupt Enable

This read/write bit enables interrupts caused by active signal on the TCAP pin. Resets clear the ICIE bit.

- 1 = Input capture interrupts enabled
- 0 = Input capture interrupts disabled
- OCIE Output Compare Interrupt Enable

This read/write bit enables interrupts caused by an active signal on the TCMP pin. Resets clear the OCIE bit.

- 1 = Output compare interrupts enabled
- 0 = Output compare interrupts disabled

TOIE — Timer Overflow Interrupt Enable

This read/write bit enables interrupts caused by a timer overflow. Resets clear the TOIE bit.

- 1 = Timer overflow interrupts enabled
- 0 = Timer overflow interrupts disabled

CAPTURE/COMPARE TIMER

IEDG — Input Edge

Freescale Semiconductor, Inc.

The state of this read/write bit determines whether a positive or negative transition on the TCAP pin triggers a transfer of the contents of the timer register to the input capture register. Resets have no effect on the IEDG bit.

1 = Positive edge (low to high transition) triggers input capture

0 = Negative edge (high to low transition) triggers input capture

OLVL — Output Level

The state of this read/write bit determines whether a logic one or a logic zero appears on the TCMP pin when a successful output compare occurs. Resets clear the OLVL bit.

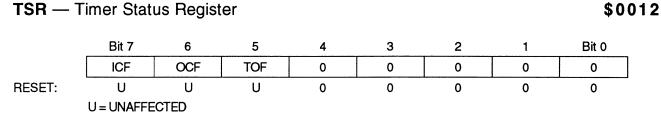
1 = TCMP goes high on output compare

0 = TCMP goes low on output compare

8.2.2 Timer Status Register (TSR)

The timer status register, shown in Figure 8-5, contains flags for the following events:

- An active signal on the TCAP pin, transferring the contents of the timer registers to the input capture registers
- A match between the 16-bit counter and the output compare registers, transferring the OLVL bit to the TCMP pin
- A timer rollover from \$FFFF to \$0000





ICF — Input Capture Flag

The ICF bit is automatically set when an edge of the selected polarity occurs on the TCAP pin. Clear the ICF bit by reading the timer status register with ICF set, and then reading the low byte (\$0015) of the input capture registers. Resets have no effect on ICF.

MOTOROLA 8-6 CAPTURE/COMPARE TIMER

MC68HC05P6

OCF — Output Compare Flag

The OCF bit is automatically set when the value of the timer registers matches the contents of the output compare registers. Clear the OCF bit by reading the timer status register with OCF set, and then accessing the low byte (\$0017) of the output compare registers. Resets have no effect on OCF.

TOF — Timer Overflow Flag

The TOF bit is automatically set when the 16-bit counter rolls over from \$FFFF to \$0000. Clear the TOF bit by reading the timer status register with TOF set, and then accessing the low byte (\$0019) of the timer registers. Resets have no effect on TOF.

8.2.3 Timer Registers (TRH and TRL)

The timer registers, shown in Figure 8-6, contain the current high and low bytes of the 16-bit counter. Reading TRH before reading TRL causes TRL to be latched until TRL is read. Reading TRL after reading the timer status register clears the timer overflow flag (TOF). Writing to the timer registers has no effect.

TRH and TRL — Timer Register High/Low

\$0018 and \$0019

| \$0018 | Bit 15 | 14 | 13 | 12 | 11 | 10 | 9 | Bit 8 |
|--------|--------|----|----|----|----|----|---|-------|
| \$0019 | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |

Reset initializes the timer registers to \$FFFC.

Figure 8-6. Timer Registers (TRH and TRL)

Reading TRH returns the current value of the high byte of the counter and causes the low byte to be latched into a buffer, as shown in Figure 8-7. The buffer value remains fixed even if the high byte is read more than once. Reading TRL reads the transparent low byte buffer and completes the read sequence of the timer registers.

CAPTURE/COMPARE TIMER



low bytes of the 16-bit counter. Reading ATRH before reading ATRL causes

ATRL to be latched until ATRL is read. Reading does not affect the timer overflow flag (TOF). Writing to the alternate timer registers has no effect.

The alternate timer registers, shown in Figure 8-8, contain the current high and

| ATRH and ATRL — Alternate | e Timer Register High/Low | \$001A |
|---------------------------|---------------------------|--------|
|---------------------------|---------------------------|--------|

| \$001A | Bit 15 | 14 | 13 | 12 | 11 | 10 | 9 | Bit 8 |
|--------|------------------|----|----|----|----|----|---|-------|
| \$001B | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
| | Design to take t | | | | | | | |

Reset initializes the alternate timer registers to \$FFFC.

8.2.4 Alternate Timer Registers (ATRH and ATRL)

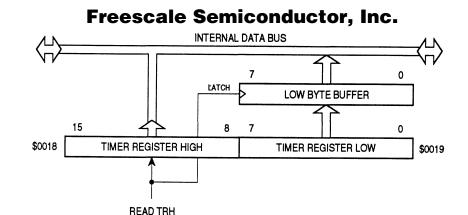
Figure 8-8. Alternate Timer Registers (ATRH and ATRL)

Reading ATRH returns the current value of the high byte of the counter and causes the low byte to be latched into a buffer, as shown in Figure 8-9. The buffer value remains fixed even if the high byte is read more than once. Reading ATRL reads the transparent low byte buffer and completes the read sequence of the alternate timer registers.

Figure 8-7. Timer Register Reads

NOTE

To prevent interrupts from occurring between readings of TRH and TRL, set the interrupt flag in the condition code register before reading TRH, and clear the flag after reading TRL.



CAPTURE/COMPARE TIMER

MC68HC05P6

and \$001B



8.2.5 Input Capture Registers (ICRH and ICRL) When a selected edge occurs on the TCAP pin, the current high and low bytes

of the 16-bit counter are latched into the input capture registers. Reading ICRH before reading ICRL inhibits further captures until ICRL is read. Reading ICRL after reading the timer status register clears the input capture flag (ICF). Writing to the input capture registers has no effect.

| ICRH and ICRL — | Input Capture | e Register High/Low |
|-----------------|---------------|---------------------|

| \$0014 | Bit 15 | 14 | 13 | 12 | 11 | 10 | 9 | Bit 8 |
|--------|--------|----|----|----|----|----|---|-------|
| \$0015 | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |

Reset does not affect the input capture registers.

Figure 8-10. Input Capture Registers (ICRH and ICRL)

Freescale Semiconductor, Inc. INTERNAL DATA BUS 0 7 LATCH LOW BYTE BUFFER 15 8 7 0 ALTERNATE TIMER REGISTER HIGH \$001A ALTERNATE TIMER REGISTER LOW \$001B READ ATRH

Figure 8-9. Alternate Timer Register Reads

NOTE

To prevent interrupts from occurring between readings of ATRH and ATRL, set the interrupt flag in the condition code register before reading ATRH, and clear the flag after reading ATRL.

| \$0014 | and | \$0015 |
|--------|-----|--------|
| | | |

To prevent interrupts from occurring between readings of ICRH and ICRL, set the interrupt flag in the condition code register before reading ICRH, and clear the flag after reading ICRL.

8.2.6 Output Compare Registers (OCRH and OCRL)

When the value of the 16-bit counter matches the value in the output compare registers, the planned TCMP pin action takes place. Writing to OCRH before writing to OCRL inhibits timer compares until OCRL is written. Reading or writing to OCRL after reading the timer status register clears the output compare flag (OCF).

OCRH and OCRL — Output Compare Register High/Low \$0016 and \$0017

| \$0016 | Bit 15 | 14 | 13 | 12 | 11 | 10 | 9 | Bit 8 |
|--------|--------|----|----|----|----|----|---|-------|
| \$0017 | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |

Reset does not affect the output compare registers.

Figure 8-11. Output Compare Registers (OCRH and OCRL)

To prevent OCF from being set between the time it is read and the time the output compare registers are updated, use the following procedure:

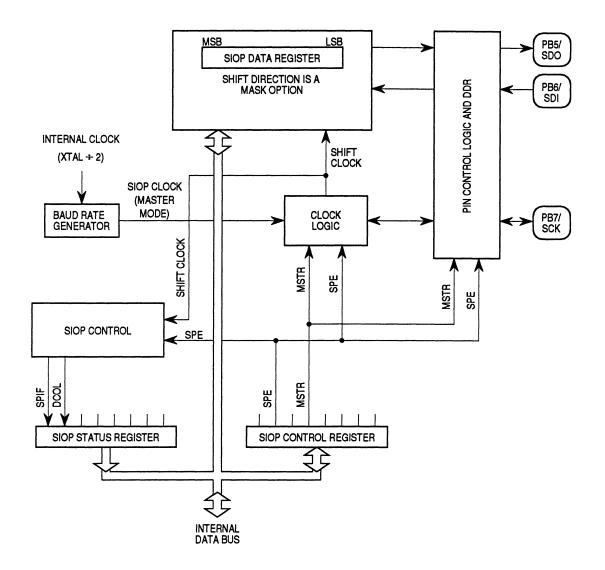
- 1. Disable interrupts by setting the I bit in the condition code register.
- 2. Write to OCRH. Compares are now inhibited until OCRL is written.
- 3. Clear bit OCF by reading the timer status register (TSR).
- 4. Enable the output compare function by writing to OCRL.
- 5. Enable interrupts by clearing the I bit in the condition code register.

MOTOROLA 8-10 CAPTURE/COMPARE TIMER

MC68HC05P6

SECTION 9 SERIAL I/O PORT (SIOP)

This section describes the operation of the serial I/O port (SIOP). Figure 9-1 shows the structure of the SIOP subsystem.





SERIAL I/O PORT (SIOP)

9.1 SIOP Operation

Freescale Semiconductor, Inc.

The SIOP enables high-speed synchronous serial data transmission between the MCU and peripheral devices. Shift registers used with the SIOP can increase the number of parallel I/O pins controlled by the MCU. More powerful peripherals such as analog-to-digital converters and real-time clocks are also compatible with the SIOP. A mask option determines whether the SIOP transmits data MSB-first or LSB-first.

9.1.1 SIOP Pin Functions

The SIOP uses the three port B I/O pins. Setting the SPE bit in the SIOP control register enables the SIOP. When the SPE bit is set, the PB7/SCK, PB6/SDI, and PB5/SDO pins are dedicated to SIOP functions. When the SPE bit is clear, the PB7/SCK, PB6/SDI, and PB5/SDO pins are bidirectional port B I/O pins.

Setting the MSTR bit in the SIOP control register configures the SIOP for master mode. In master mode, the PB7/SCK pin is the serial clock output. PB6/SDI is the serial data input pin, and PB5/SDO is the serial data output pin. The master MCU initiates and controls the transmission of data to and from one or more slave peripheral devices. In master mode, a transmission is initiated by writing to the SIOP data register. Data written to the SIOP data register is parallel-loaded and shifted out serially to the slave device(s).

MOTOROLA 9-2 SERIAL I/O PORT (SIOP)

MC68HC05P6

9.1.2 Serial Clock

Freescale Semiconductor, Inc.

The PB7/SCK pin synchronizes the movement of data into and out of the MCU through the PB6/SDI and PB5/SDO pins. In master mode, the PB7/SCK pin is an output. The transmission rate for master mode is a mask option.

In slave mode, the PB7/SCK pin is an input. The maximum serial clock rate for slave mode is the maximum internal clock rate divided by four. There is no minimum serial clock frequency for slave mode.

Figure 9-2 shows the timing relationships between the serial clock, data input, and data output. The state of the serial clock between transmissions is a logic one. The first falling edge on the PB7/SCK pin signals the beginning of a transmission, and data appears at the PB5/SDO pin. Data is captured at the PB6/SDI pin on the rising edge of the serial clock, and the transmission ends on the eighth rising edge of the serial clock.

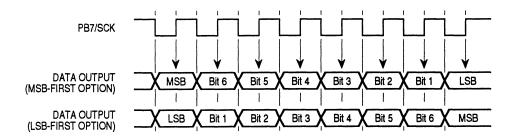


Figure 9-2. SIOP Data/Clock Timing

Valid SDI data must be present for an SDI setup time before the rising edge of the serial clock and must remain valid for an SDI hold time after the rising edge of the serial clock. (See 13.9 SIOP Timing ($V_{DD} = 5.0 \text{ Vdc}$) and 13.10 SIOP Timing ($V_{DD} = 3.3 \text{ Vdc}$).)

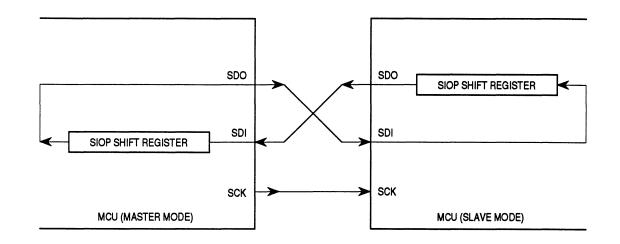
Between transmissions, the state of the PB5/SDO pin reflects the value of the last bit received on the previous transmission. On the first falling edge on the PB7/SCK pin, the first data bit to be shifted out appears at the PB5/SDO pin.

MC68HC05P6

SERIAL I/O PORT (SIOP)

9.1.3 Data Movement

Connecting the SIOP data register of a master MCU with the SIOP of a slave MCU forms a 16-bit circular shift register. During a SIOP transmission, the master shifts out the contents of its SIOP data register on its PB5/SDO pin. At the same time, the slave MCU shifts out the contents of its SIOP data register on its SDO pin. Figure 9-3 shows how the master and slave exchange the contents of their data registers.



NOTE: Both MCUs shown are programmed for MSB-first data format.

Figure 9-3. Master/Slave SIOP Shift Register Operation

9.2 SIOP I/O Registers

The following registers control and monitor SIOP operation:

- SIOP control register (SCR)
- SIOP status register (SSR)
- SIOP data register (SDR)

9.2.1 SIOP Control Register (SCR)

The read/write SIOP control register, shown in Figure 9-4, contains two bits. One bit enables the SIOP, and the other configures the SIOP for master mode or for slave mode.

MOTOROLA 9-4 SERIAL I/O PORT (SIOP)

MC68HC05P6

SCR — SIOP Control Register

\$000A

| | Bit 7 | 6 | 5 | 4 | 3 | 2 | 1 | Bit 0 |
|--------|-------|-----|---|------|---|---|---|-------|
| | 0 | SPE | 0 | MSTR | 0 | 0 | 0 | 0 |
| RESET: | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |



SPE - SIOP Enable

This read/write bit enables the SIOP. Clearing the SPE bit during a transmission aborts the transmission and returns port B to its normal I/O function. After clearing the SPE bit, be sure to initialize the port B data direction register for the intended port B I/O use. Resets clear SPE.

- 1 = SIOP enabled
- 0 = SIOP disabled

MSTR — Master Mode Select

This read/write bit configures the SIOP for master mode. Setting MSTR initializes the PB7/SCK pin as the serial clock output. Clearing MSTR initializes the PB7/SCK pin as the serial clock input. Resets clear MSTR.

1 = Master mode selected

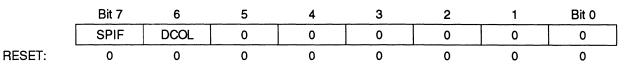
0 = Slave mode selected

9.2.2 SIOP Status Register (SSR)

The read/write SIOP status register, shown in Figure 9-5, contains two bits. One bit indicates that a SIOP transmission is complete, and the other indicates that an access of the SIOP status register occurred while a transmission was in progress.

SSR — SIOP Status Register





| Figure 9 | 9-5. | SIOP | Status | Register | (SCR) |
|----------|------|------|--------|----------|-------|
|----------|------|------|--------|----------|-------|

MC68HC05P6

SERIAL I/O PORT (SIOP)

SPIF — SIOP Interrupt Flag

Freescale Semiconductor, Inc.

This clearable, read-only bit is set automatically at the end of a transmission. Clear the SPIF bit by reading the SIOP status register with SPIF set, and then reading or writing the SIOP data register. Resets clear the SPIF bit.

1 = Serial transmission complete

0 = Serial transmission not complete

DCOL — Data Collision

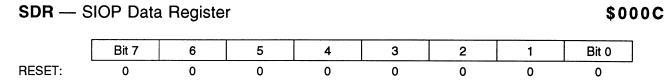
This clearable, read-only bit is set if the SIOP data register is read or written during a transmission. Clear the DCOL bit by reading the SIOP status register with the SPIF bit set, and then reading or writing the SIOP data register. Resets clear the DCOL bit.

1 = Invalid access of SIOP status register

0 = No invalid access of SIOP status register

9.2.3 SIOP Data Register (SDR)

The SIOP data register, shown in Figure 9-6, is both the transmit data register and the receive data register. To read or write the SIOP data register, the SPE bit in the SIOP control register must be set.





With the SIOP configured as master, writing to the SIOP data register initiates a serial transmission. This register is not buffered. Writing to the SIOP data register overwrites the previous contents. Reading or writing to the SIOP data register while a transmission is in progress can cause invalid data to be transmitted or received.

MOTOROLA 9-6 SERIAL I/O PORT (SIOP)

MC68HC05P6

SECTION 10 ANALOG-TO-DIGITAL CONVERTER (ADC)

This section describes the four-channel, 8-bit, successive approximation ADC.

10.1 ADC Operation

Figure 10-1 shows the structure of the ADC.

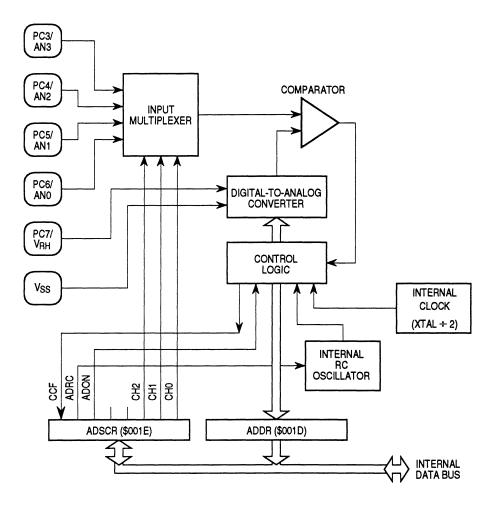


Figure 10-1. ADC Block Diagram

MC68HC05P6

ANALOG-TO-DIGITAL CONVERTER (ADC)

MOTOROLA 10-1

Freescale Semiconductor, Inc. A multiplexer selects one of four external analog signals for sampling. The CH2-CH0 bits in the ADC status and control register (ADSCR) control input selection.

A comparator makes successive comparisons of the selected analog input and the output of a precision digital-to-analog converter (DAC). Control logic changes the input to the DAC one bit at a time, starting with the MSB, until the DAC output matches the selected analog input. The conversion is monotonic and has no missing codes. At the end of 32 internal clock cycles, the conversion complete (CC) flag becomes set, and the digital conversion is readable in the ADC data register (ADDR).

For ratiometric conversion, the supply voltage of the analog source should be the same as V_{BH} and be referenced to V_{SS} . An analog input voltage equal to V_{BH} converts to digital \$FF; an input voltage greater than V_{BH} converts to \$FF with no overflow. An analog input voltage equal to V_{SS} converts to digital \$00.

10.1.1 Pin Functions

Port C shares five of its pins with the ADC. The following paragraphs describe the ADC pin functions.

10.1.1.1 PC7/V_{RH}

The $PC7/V_{BH}$ pin supplies the high reference voltage for the ratiometric conversion process. The low reference is connected internally to V_{SS}.

10.1.1.2 PC6/AN0, PC5/AN1, PC4/AN2, and PC3/AN3

PC6/AN0, PC5/AN1, PC4/AN2, and PC3/AN3 are the analog inputs to the ADC.

10.1.2 Conversion Accuracy

Conversion accuracy of ± 1.5 LSB is guaranteed when $V_{RH} = V_{DD}$.

10.1.3 Conversion Time

Each input conversion takes 32 internal clock cycles. The internal clock frequency must be equal to or greater than 1 MHz.

ANALOG-TO-DIGITAL CONVERTER (ADC)

MC68HC05P6

10.1.4 Internal RC Oscillator

If the internal clock frequency is less than 1 MHz, the internal RC oscillator must be used for the ADC clock instead of the internal clock. The nominal frequency of the RC oscillator is 1.5 MHz. Select the internal RC oscillator by setting the ADRC bit in the ADSCR.

Since the RC oscillator is not synchronous with the internal clock, software must rely on the CC bit to determine when each conversion process is complete.

Using the RC oscillator may slightly degrade ADC accuracy. The ADC reads voltages only during the periods when the clock driving it is not changing. But since the RC oscillator and the internal clock are not synchronous, the ADC occasionally reads voltages during internal clock transitions.

When the internal clock frequency is 1 MHz or greater, the RC oscillator must be turned off.

10.2 ADC I/O Registers

The following registers control and monitor operation of the ADC:

- ADC status and control register (ADSCR)
- ADC data register (ADDR)

10.2.1 ADC Status and Control Register (ADSCR)

The ADC status and control register, shown in Figure 10-2, contains a conversion complete flag and performs the following control functions:

- Turns on the ADC
- Turns on the internal RC oscillator
- Selects the analog inputs

Writing to ADSCR clears the conversion complete flag and starts a new conversion sequence.

MC68HC05P6

ANALOG-TO-DIGITAL CONVERTER (ADC)

Freescale Semiconductor, Inc. ADSCR — ADC Status and Control Register

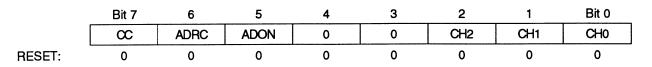


Figure 10-2. ADC Status and Control Register (ADSCR)

CC — Conversion Complete

This read-only bit is automatically set at the end of each conversion process. When CC is set, the result of the conversion is readable in the ADDR. Clear the CC bit by writing to the CH2–CH0 bits or by clearing the ADON bit or by reading the ADDR. Resets clear CC.

1 = Conversion complete

0 = Conversion not complete

ADRC — ADC RC (Oscillator)

This read/write bit turns on the internal RC oscillator to drive the ADC. If the internal clock frequency (f_{OP}) is less than 1 MHz, ADRC must be set. When the RC oscillator is turned on, it requires a time, t_{ADRC} , to stabilize, and results can be inaccurate during this time. Resets clear ADRC.

1 = Internal RC oscillator drives ADC

0 = Internal clock drives ADC

ADON — ADC On

This read/write bit turns on the ADC. When the ADC is on, it requires a time, t_{ADON}, for the current sources to stabilize. During this time, results can be inaccurate. Resets clear ADON.

1 = ADC turned on

0 = ADC turned off

Bits 4-2 - Not used

Bits 4-2 always read as logic zeros.

MOTOROLA 10-4 ANALOG-TO-DIGITAL CONVERTER (ADC)

MC68HC05P6

CH2–CH0 — Channel 2–Channel 0

These read/write bits select one of eight ADC input channels as shown in Table 10-1. Channels 0–3 are the port C input pins, PC3/AN3, PC4/AN2, PC5/AN1, and PC6/AN0. Channels 4–6 can be used for reference measurements. Channel 7 is reserved for factory testing.

| CH[2:1:0] | Channel | Signal |
|-----------|---------|--|
| 000 | 0 | AN0 Port C Bit 6 |
| 001 | 1 | AN1 Port C Bit 5 |
| 010 | 2 | AN2 Port C Bit 4 |
| 011 | 3 | AN3 Port C Bit 3 |
| 100 | 4 | V _{RH} Port C Bit 7 |
| 101 | 5 | (V _{RH} + V _{SS}) ÷ 2 |
| 110 | 6 | Vss |
| 111 | 7 | Reserved |

Table 10-1. ADC Input Channel Selection

To prevent excess power dissipation, do not use a port C pin as an analog input and a digital input at the same time.

Using one of the port C pins as the ADC input does not affect the ability to use the remaining port C pins as digital inputs.

Reading a port C pin that is selected as an analog input returns a logic zero.

MC68HC05P6

ANALOG-TO-DIGITAL CONVERTER (ADC)

MOTOROLA 10-5

Freescale Semiconductor, Inc. 10.2.2 ADC Data Register (ADDR)

The ADC data register is a read-only register that contains the result of the most recent analog-to-digital conversion.

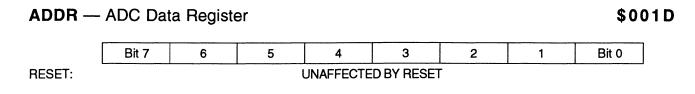


Figure 10-3. ADC Data Register (ADDR)

MOTOROLA 10-6 ANALOG-TO-DIGITAL CONVERTER (ADC)

MC68HC05P6

SECTION 11 SELF-CHECK ROM

This section describes how to use the self-check ROM to test MCU operation.

11.1 Self-Check Tests

To check for proper MCU operation, the self-check ROM performs the following tests:

- I/O test A functional exercise of ports A, B, and C
- RAM test A counter test for each page zero RAM byte
- Capture/compare timer test A test of the counter register and the output compare function
- ROM test An exclusive OR odd parity check
- ADC test A test of reference voltage levels
- Interrupt test A test of internal interrupts and the RTI instruction

Figure 11-1 shows the circuit required to execute the self-check tests.

11.2 Self-Check Results

Table 11-1 shows the LED codes that indicate self-check test results.

| PC3 | PC2 | PC1 | PC0 | Problem | |
|-----|-----------|----------|-----|-------------------|--|
| ON | OFF | OFF | ON | I/O Failure | |
| ON | OFF | OFF | OFF | RAM Failure | |
| OFF | ON | ON | ON | Timer Failure | |
| OFF | ON | ON | OFF | ROM Failure | |
| OFF | ON | OFF | ON | ADC Failure | |
| OFF | ON | OFF | OFF | Interrupt Failure | |
| | Flas | hing | | No Failures | |
| | All Other | Patterns | ; | Device Failure | |

Table 11-1. Self-Check Circuit LED Codes

MC68HC05P6

SELF-CHECK ROM

Freescale Semiconductor, Inc. 11.3 Self-Check Circuit

Figure 11-1 shows the self-check circuit.

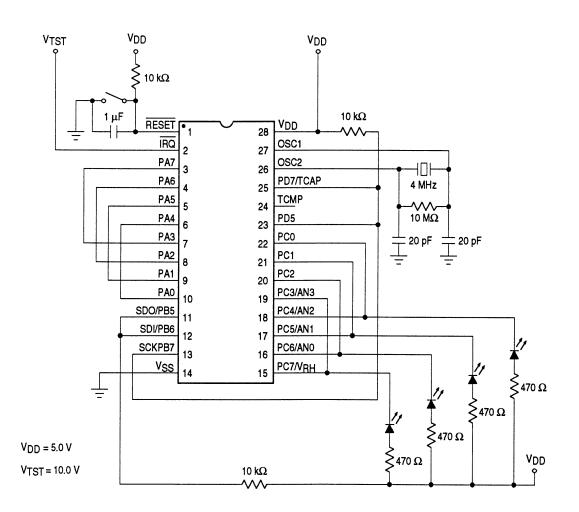


Figure 11-1. Self-Check Circuit

Perform the following steps to activate the self-check tests:

- 1. Apply V_{TST} to the \overline{IRQ} pin.
- 2. Apply a logic zero to the $\overline{\text{RESET}}$ pin.
- 3. Apply a logic one to the PD1 pin.
- 4. Apply a logic one to the PB2 pin.
- 5. Apply a logic one to the $\overline{\text{RESET}}$ pin.

The self-check tests begin on the rising edge of the $\overline{\text{RESET}}$ pin.

MOTOROLA 11-2 SELF-CHECK ROM

MC68HC05P6

SECTION 12 INSTRUCTION SET

This section describes the addressing modes and the types of instructions.

12.1 Addressing Modes

The CPU uses eight addressing modes for flexibility in accessing data. These addressing modes define the manner in which the CPU finds the data required to execute an instruction. The eight addressing modes are as follows:

- Inherent
- Immediate
- Direct
- Extended
- Indexed, no offset
- Indexed, 8-bit offset
- Indexed, 16-bit offset
- Relative

MC68HC05P6

INSTRUCTION SET

MOTOROLA 12-1

12.1.1 Inherent

Inherent instructions are those that have no operand, such as return from interrupt (RTI) and stop (STOP). Some of the inherent instructions act on data in the CPU registers, such as set carry flag (SEC) and increment accumulator (INCA). Inherent instructions require no memory address and are one byte long. Table 12-1 lists the instructions that use inherent addressing.

| Instruction | Mnemonic |
|---|------------|
| Arithmetic Shift Left | ASLA, ASLX |
| Arithmetic Shift Right | ASRA, ASRX |
| Clear Carry Bit | CLC |
| Clear Interrupt Mask | CLI |
| Clear | CLRA, CLRX |
| Complement | COMA, COMX |
| Decrement | DECA, DECX |
| Increment | INCA, INCX |
| Logical Shift Left | LSLA, LSLX |
| Logical Shift Right | LSRA, LSRX |
| Multiply Index Register by Accumulator (Unsigned) | MUL |
| Negate | NEGA, NEGX |
| No Operation | NOP |
| Rotate Left through Carry | ROLA, ROLX |
| Rotate Right through Carry | RORA, RORX |
| Reset Stack Pointer | RSP |
| Return from Interrupt | RTI |
| Return from Subroutine | RTS |
| Set Carry Bit | SEC |
| Set Interrupt Mask | SEI |
| Enable IRQ and Stop Oscillator | STOP |
| Software Interrupt | SWI |
| Transfer Accumulator to Index Register | TAX |
| Test for Negative or Zero | TSTA, TSTX |
| Transfer Index Register to Accumulator | TXA |
| Enable Interrupts and Halt CPU | WAIT |

Table 12-1. Inherent Addressing Instructions

MOTOROLA 12-2

INSTRUCTION SET

MC68HC05P6

12.1.2 Immediate

Immediate instructions are those that contain a value to be used in an operation with the value in the accumulator or index register. Immediate instructions require no memory address and are two bytes long. The opcode is the first byte and the immediate data value is the second byte. Table 12-2 lists the instructions that use immediate addressing.

| Instruction | Mnemonic |
|--|----------|
| Add Memory and Carry to Accumulator | ADC |
| Add Memory to Accumulator | ADD |
| Logical AND Memory with Accumulator | AND |
| Bit Test Memory with Accumulator (Logical Compare) | BIT |
| Arithmetic Compare Accumulator with Memory | CMP |
| Arithmetic Compare Index Register with Memory | CPX |
| Exclusive OR Memory with Accumulator | EOR |
| Load Accumulator from Memory | LDA |
| Load Index Register from Memory | LDX |
| Logical Inclusive OR Memory with Accumulator | ORA |
| Subtract Memory and Carry from Accumulator | SBC |
| Subtract Memory from Accumulator | SUB |

Table 12-2. Immediate Addressing Instructions

MC68HC05P6

INSTRUCTION SET

MOTOROLA 12-3

12.1.3 Direct

Direct instructions can access any of the first 256 memory addresses with two bytes. The first byte is the opcode, and the second is the low byte of the operand address. In direct addressing, the CPU automatically uses \$00 as the high byte of the operand address. BRSET and BRCLR are three-byte instructions that use direct addressing to access the operand and relative addressing to specify a branch destination. Table 12-3 lists the instructions that use direct addressing.

| Instruction | Mnemonic |
|--|----------|
| Add Memory and Carry to Accumulator | ADC |
| Add Memory to Accumulator | ADD |
| Logical AND Memory with Accumulator | AND |
| Arithmetic Shift Left | ASL |
| Arithmetic Shift Right | ASR |
| Clear Bit | BCLR |
| Bit Test Memory with Accumulator (Logical Compare) | BIT |
| Branch if Bit Clear | BRCLR |
| Branch if Bit Set | BRSET |
| Set Bit | BSET |
| Clear | CLR |
| Arithmetic Compare Accumulator with Memory | CMP |
| Complement | COM |
| Arithmetic Compare Index Register with Memory | CPX |
| Decrement | DEC |
| Exclusive OR Memory with Accumulator | EOR |
| Increment | INC |
| Jump | JMP |
| Jump to Subroutine | JSR |
| Load Accumulator from Memory | LDA |
| Load Index Register from Memory | LDX |
| Logical Shift Left | LSL |
| Logical Shift Right | LSR |
| Negate | NEG |
| Logical Inclusive OR Memory with Accumulator | ORA |
| Rotate Left through Carry | ROL |
| Rotate Right through Carry | ROR |
| Subtract Memory and Carry from Accumulator | SBC |
| Store Accumulator in Memory | STA |
| Store Index Register in Memory | STX |
| Subtract Memory from Accumulator | SUB |
| Test for Negative or Zero | TST |

 Table 12-3. Direct Addressing Instructions

MOTOROLA 12-4 INSTRUCTION SET

MC68HC05P6

12.1.4 Extended

Extended instructions use only three bytes to access any address in memory. The first byte is the opcode; the second and third bytes are the high and low bytes of the operand address.

When using the Motorola assembler, the programmer does not need to specify whether an instruction is direct or extended. The assembler automatically selects the shortest form of the instruction. Table 12-4 lists the instructions that use extended addressing.

| Instruction | Mnemonic |
|--|----------|
| Add Memory and Carry to Accumulator | ADC |
| Add Memory to Accumulator | ADD |
| Logical AND Memory with Accumulator | AND |
| Bit Test Memory with Accumulator (Logical Compare) | BIT |
| Arithmetic Compare Accumulator with Memory | CMP |
| Arithmetic Compare Index Register with Memory | СРХ |
| Exclusive OR Memory with Accumulator | EOR |
| Jump | JMP |
| Jump to Subroutine | JSR |
| Load Accumulator from Memory | LDA |
| Load Index Register from Memory | LDX |
| Logical Inclusive OR Memory with Accumulator | ORA |
| Subtract Memory and Carry from Accumulator | SBC |
| Store Accumulator in Memory | STA |
| Store Index Register in Memory | STX |
| Subtract Memory from Accumulator | SUB |

| Table | 12-4. | Extended | Addressing | Instructions |
|-------|-------|----------|------------|--------------|
|-------|-------|----------|------------|--------------|

MC68HC05P6

INSTRUCTION SET

12.1.5 Indexed, No Offset

Indexed instructions with no offset are one-byte instructions that can access data with variable addresses within the first 256 memory locations. The index register contains the low byte of the conditional address of the operand. The CPU automatically uses \$00 as the high byte, so these instructions can address locations \$0000–\$00FF.

Indexed, no offset instructions are often used to move a pointer through a table or to hold the address of a frequently used RAM or I/O location. Table 12-5 lists the instructions that use indexed, no offset addressing.

12.1.6 Indexed, 8-Bit Offset

Indexed, 8-bit offset instructions are two-byte instructions that can access data with variable addresses within the first 511 memory locations. The CPU adds the unsigned byte in the index register to the unsigned byte following the opcode. The sum is the conditional address of the operand. These instructions can access locations \$0000-\$01FE.

Indexed, 8-bit offset instructions are useful for selecting the kth element in an n-element table. The table can begin anywhere within the first 256 memory locations and could extend as far as location 510 (\$01FE). The k value would typically be in the index register, and the address of the beginning of the table would be in the byte following the opcode. Table 12-5 lists the instructions that use indexed, 8-bit offset addressing.

12.1.7 Indexed, 16-Bit Offset

Indexed, 16-bit offset instructions are three-byte instructions that can access data with variable addresses at any location in memory. The CPU adds the unsigned byte in the index register to the two unsigned bytes following the opcode. The sum is the conditional address of the operand. The first byte after the opcode is the high byte of the 16-bit offset; the second byte is the low byte of the offset. These instructions can address any location in memory.

Indexed, 16-bit offset instructions are useful for selecting the kth element in an n-element table anywhere in memory.

As with direct and extended addressing, the Motorola assembler determines the shortest form of indexed addressing. Table 12-5 lists the instructions that use indexed, 16-bit offset addressing.

MOTOROLA 12-6 INSTRUCTION SET

MC68HC05P6

| Instruction | Mnemonic | No Offset | 8-Bit Offset | 16-Bit Offset |
|--|----------|--------------|-----------------|------------------|
| Add Memory and Carry to Accumulator | ADC | \checkmark | V | 1 |
| Add Memory to Accumulator | ADD | \checkmark | 1 | 1 |
| Logical AND Memory with Accumulator | AND | V | V | \checkmark |
| Arithmetic Shift Left | ASL | \checkmark | \checkmark | |
| Arithmetic Shift Right | ASR | \checkmark | \checkmark | |
| Bit Test Memory with Accumulator (Logical Compare) | BIT | \checkmark | V | 1 |
| Clear | CLR | \checkmark | √ | |
| Arithmetic Compare Accumulator with Memory | CMP | \checkmark | \checkmark | 1 |
| Complement | COM | \checkmark | \checkmark | |
| Arithmetic Compare Index Register with Memory | CPX | \checkmark | \checkmark | 1 |
| Decrement | DEC | \checkmark | V | |
| Exclusive OR Memory with Accumulator | EOR | \checkmark | √ | 1 |
| Increment | INC | \checkmark | V | |
| Jump | JMP | \checkmark | V | V |
| Jump to Subroutine | JSR | \checkmark | \checkmark | \checkmark |
| Load Accumulator from Memory | LDA | \checkmark | V | \checkmark |
| Load Index Register from Memory | LDX | \checkmark | \checkmark | \checkmark |
| Logical Shift Left | LSL | \checkmark | V | |
| Logical Shift Right | LSR | \checkmark | V | |
| Negate | NEG | \checkmark | \checkmark | |
| Logical Inclusive OR Memory with Accumulator | ORA | \checkmark | V | \checkmark |
| Rotate Left through Carry | ROL | \checkmark | V | |
| Rotate Right through Carry | ROR | \checkmark | √ | |
| Subtract Memory and Carry from Accumulator | SBC | V | \checkmark | 1 |
| Store Accumulator in Memory | STA | V | V | 1 |
| Store Index Register in Memory | STX | \checkmark | 1 | 1 |
| Subtract Memory from Accumulator | SUB | V | V | V |
| Test for Negative or Zero | TST | V | V | |

Freescale Semiconductor, Inc. Table 12-5. Indexed Addressing Instructions

MC68HC05P6

INSTRUCTION SET

MOTOROLA 12-7

12.1.8 Relative

Relative addressing is only for branch instructions and bit test and branch instructions. If the branch condition is true, the CPU finds the conditional branch destination by adding the signed byte following the opcode to the contents of the program counter. If the branch condition is not true, the CPU goes to the next instruction. The offset is a signed, two's complement byte that gives a branching range of -128 to +127 bytes from the address of the next location after the branch instruction.

When using the Motorola assembler, the programmer does not need to calculate the offset, because the assembler determines the proper offset and verifies that it is within the span of the branch. Table 12-6 lists the instructions that use relative addressing.

| Instruction | Mnemonic |
|--------------------------------|----------|
| Branch if Carry Clear | BCC |
| Branch if Carry Set | BCS |
| Branch if Equal | BEQ |
| Branch if Half-Carry Clear | BHCC |
| Branch if Half-Carry Set | BHCS |
| Branch if Higher | BHI |
| Branch if Higher or Same | BHS |
| Branch if Interrupt Line High | BIH |
| Branch if Interrupt Line Low | BIL |
| Branch if Lower | BLO |
| Branch if Lower or Same | BLS |
| Branch if Interrupt Mask Clear | BMC |
| Branch if Minus | BMI |
| Branch if Interrupt Mask Set | BMS |
| Branch if Not Equal | BNE |
| Branch if Plus | BPL |
| Branch Always | BRA |
| Branch if Bit Clear | BRCLR |
| Branch if Bit Set | BRSET |
| Branch Never | BRN |
| Branch to Subroutine | BSR |

Table 12-6. Relative Addressing Instructions

Semiconductor, Inc.

reescale

INSTRUCTION SET

MC68HC05P6

12.2 Instruction Types

The MCU instructions fall into the following five categories:

- Register/memory
- Read-modify-write
- Jump/branch
- Bit manipulation
- Control

12.2.1 Register/Memory Instructions

Most of these instructions use two operands. One operand is in either the accumulator or the index register. The CPU finds the other operand in memory. Register/memory instructions use all the addressing modes except relative.

Table 12-7 lists the register/memory instructions.

| Instruction | Mnemonic |
|--|----------|
| Load Accumulator from Memory | LDA |
| Load Index Register from Memory | LDX |
| Store Accumulator in Memory | STA |
| Store Index Register in Memory | STX |
| Add Memory to Accumulator | ADD |
| Add Memory and Carry to Accumulator | ADC |
| Subtract Memory from Accumulator | SUB |
| Subtract Memory and Carry from Accumulator | SBC |
| Logical AND Memory with Accumulator | AND |
| Logical Inclusive OR Memory with Accumulator | ORA |
| Logical Exclusive OR Memory with Accumulator | EOR |
| Arithmetic Compare Accumulator with Memory | CMP |
| Arithmetic Compare Index Register with Memory | СРХ |
| Bit Test Memory with Accumulator (Logical Compare) | BIT |
| Multiply Index Register by Accumulator (Unsigned) | MUL |

Table 12-7. Register/Memory Instructions

MC68HC05P6

INSTRUCTION SET

MOTOROLA 12-9

12.2.2 Read-Modify-Write Instructions

These instructions read a memory location or a register, modify its contents, and write the modified value back to the memory location or to the register. The test for negative or zero (TST) instruction is an exception to the read-modify-write sequence because it does not write a replacement value. Read-modify-write instructions use the following addressing modes:

- Inherent
- Direct
- Indexed, no offset
- Indexed, 8-bit offset

Table 12-8 lists the read-modify-write instructions.

| Instruction | Mnemonic |
|-------------------------------------|----------|
| Increment | INC |
| Decrement | DEC |
| Clear | CLR |
| Complement | COM |
| Negate (Two's Complement) | NEG |
| Rotate Left through Carry | ROL |
| Rotate Right through Carry | ROR |
| Logical Shift Left (Same as ASL) | LSL |
| Logical Shift Right | LSR |
| Arithmetic Shift Left (Same as LSL) | ASL |
| Arithmetic Shift Right | ASR |
| Test for Negative or Zero | TST |

| Table | 12-8. | Read-Modify-Write | Instructions |
|-------|-------|--------------------------|--------------|
|-------|-------|--------------------------|--------------|

12.2.3 Jump/Branch Instructions

Jump instructions allow the CPU to interrupt the normal sequence of the program counter. The unconditional jump (JMP) and jump to subroutine (JSR) instructions have no register operand. Jump instructions use the following addressing modes:

- Direct
- Extended
- Indexed, no offset

MOTOROLA 12-10 INSTRUCTION SET

MC68HC05P6

- Indexed, 8-bit offset
- Indexed, 16-bit offset

Branch instructions allow the CPU to interrupt the normal sequence of the program counter when a test condition is met. If the test condition is not met, the branch is not performed. All branch instructions use relative addressing.

Bit test and branch instructions cause a branch based on the state of any readable bit in the first 256 memory locations. These three-byte instructions use a combination of direct addressing and relative addressing. The direct address of the byte to be tested is in the byte following the opcode. The third byte is the signed offset byte. The CPU finds the conditional branch destination by adding the third byte to the program counter if the specified bit tests true. The bit to be tested and its condition (set or clear) is part of the opcode. The span of branching is from -128 to +127 from the address of the next location after the branch instruction. The CPU also transfers the tested bit to the carry/borrow bit of the condition code register. Table 12-9 lists the jump and branch instructions.

| Instruction | Mnemonic |
|-----------------------------------|----------|
| Branch Always | BRA |
| Branch Never | BRN |
| Branch if Bit Clear | BRCLR |
| Branch if Bit Set | BRSET |
| Branch if Higher | BHI |
| Branch if Lower or Same | BLS |
| Branch if Carry Clear | BCC |
| Branch if Higher or Same | BHS |
| Branch if Carry Set (Same as BLO) | BCS |
| Branch if Lower (Same as BCS) | BLO |
| Branch if Not Equal | BNE |
| Branch if Equal | BEQ |
| Branch if Half-Carry Bit Clear | BHCC |
| Branch if Half-Carry Bit Set | BHCS |
| Branch if Plus | BPL |
| Branch if Minus | BMI |
| Branch if Interrupt Mask Clear | BMC |
| Branch if Interrupt Mask Set | BMS |
| Branch if Interrupt Line Low | BIL |
| Branch if Interrupt Line High | BIH |
| Branch to Subroutine | BSR |
| Jump | JMP |
| Jump to Subroutine | JSR |

Table 12-9. Jump and Branch Instructions

INSTRUCTION SET

MOTOROLA 12-11

Freescale Semiconductor, Inc. 12.2.4 Bit Manipulation Instructions

The CPU can set or clear any writable bit in the first 256 bytes of memory. Port registers, port data direction registers, timer registers, and on-chip RAM locations are in the first 256 bytes of memory. The CPU can also test and branch based on the state of any bit in any of the first 256 memory locations. Bit manipulation instructions use direct addressing. Table 12-10 lists these instructions.

| Instruction | Mnemonic |
|---------------------|----------|
| Set Bit | BSET |
| Clear Bit | BCLR |
| Branch if Bit Clear | BRCLR |
| Branch if Bit Set | BRSET |

| Table | 12-10. | Bit | Manipulation | Instructions |
|-------|--------|-----|--------------|--------------|
|-------|--------|-----|--------------|--------------|

12.2.5 Control Instructions

These register reference instructions control CPU operation during program execution. Control instructions, listed in Table 12-11, use inherent addressing.

| Instruction | Mnemonic |
|--|----------|
| Transfer Accumulator to Index Register | TAX |
| Transfer Index Register to Accumulator | TXA |
| Set Carry Bit | SEC |
| Clear Carry Bit | CLC |
| Set Interrupt Mask | SEI |
| Clear Interrupt Mask | CLI |
| Software Interrupt | SWI |
| Return from Subroutine | RTI |
| Reset Stack Pointer | RSP |
| No Operation | NOP |
| Stop | STOP |
| Wait | WAIT |

Table 12-11. Control Instructions

INSTRUCTION SET

MC68HC05P6

12.3 Instruction Set Summary

Table 12-12 shows all MC68HC05P6 instructions in all possible addressing modes. The table shows the operand construction and the execution time in internal clock cycles (t_{CYC}) of each instruction. One internal clock cycle equals two oscillator input cycles. The following legend summarizes the symbols and abbreviations used in Table 12-12.

Abbreviations and Symbols

| A | Accumulator | РСН | Program counter high byte |
|-------|---|----------|-------------------------------------|
| С | Carry/borrow flag | PCL | Program counter low byte |
| CCR | Condition code register | REL | Relative addressing |
| dd | Address of operand in direct addressing | rel | Offset byte for relative addressing |
| dd rr | Address (dd) of operand and offset (rr) of branch instruction for bit test instructions | rr | Offset byte of branch instruction |
| DIR | Direct addressing | SP | Stack pointer |
| ee ff | High (ee) and low (ff) bytes of offset in indexed, 16-bit offset addressing | Х | Index register |
| EXT | Extended addressing | Z | Zero flag |
| ff | Offset byte in indexed, 8-bit offset addressing | • | AND |
| н | Half-carry flag | - | Not affected |
| hh ll | High (hh) and low (II) bytes of operand address in extended addressing | ? | lf |
| 1 | Interrupt mask | | NOT |
| ii | Operand byte for immediate addressing | () | Contents of |
| IMM | Immediate addressing | ← | Is loaded with |
| INH | Inherent addressing | : | Concatenated with |
| IX | Indexed, no offset addressing | × | Multiplication |
| IX1 | Indexed, 8-bit offset addressing | -() | Negation (two's complement) |
| IX2 | Indexed, 16-bit offset addressing | ÷ | Inclusive OR |
| М | Any memory location (1 byte) | \$ | Set if true; clear if not true |
| Ν | Negative flag | \oplus | Exclusive OR |
| n | Any bit (7,6,5 0) | + | Addition |
| opr | Operand byte | - | Subtraction |
| PC | Program counter | | |
| | | | |

MC68HC05P6

INSTRUCTION SET

MOTOROLA 12-13

| | | Freescale 3 | | nuuc | .or, m | | | | | | |
|--------------------|---------------------------------------|------------------------------|------------|----------|---------|--------|----|----------|------|-----|----------|
| Source | | | Addressing | Machine | Coding | | | Co | ndit | ion | |
| Form(s) | Operation | Description | Mode for | | ecimal) | Cycles | | | Cod | | |
| | | | Operand | Opcode | Operand | - | н | I | N | Z | С |
| ADC opr | Add with carry | $A \leftarrow (A) + (M) + C$ | IMM | A9 | 11 | 2 | \$ | - | \$ | \$ | \$ |
| | | | DIR | B9 | dd | 3 | | | | | |
| | | | EXT | C9 | hh II | 4 | | | | | |
| | | | IX2 | D9 | ee ff | 5 | | | | | |
| | | | IX1 | E9 | ff | 4 | | | | | |
| | | | IX | F9 | | 3 | | | | | |
| ADD opr | Add without carry | $A \leftarrow (A) + (M)$ | IMM | AB | ii | 2 | \$ | - | \$ | \$ | \$ |
| | | | DIR | BB | dd | 3 | | | | | |
| | | | EXT | CB | hh II | 4 | | | | | |
| | | | IX2 | DB | ee ff | 5 | | | | | |
| | | | IX1 | EB | ff | 4 | | | | | |
| | | | IX | FB | | 3 | | | | | |
| AND opr | Logical AND | A ← (A) • (M) | ІММ | A4 | ii | 2 | - | - | \$ | \$ | - |
| | | | DIR | B4 | dd | 3 | | | | | |
| | | | EXT | C4 | hh II | 4 | | | | | |
| | | | IX2 | D4 | ee ff | 5 | | | | | |
| | | | IX1 | E4 | ff | 4 | | | | | |
| | | | IX | F4 | | 3 | | | | | <u> </u> |
| ASL opr | Arithmetic shift left (Same as LSL) | | DIR | 38 | dd | 5 | - | - | \$ | \$ | \$ |
| ASLA | , | | INH | 48 | | 3 | | | | | |
| ASLX ASL opr | | 67 60 | INH IX1 | 58 68 | ff | 3 | | | | | |
| | | | | 68 78 | 11 | 6 5 | | | | | |
| ASL opr | Arithmetic shift right | | DIR | 37 | dd | 5 | | | | | |
| ASR opr ASRA | Anthimetic shint right | | INH | 37 47 | aa | 3 | - | - | \$ | \$ | \$ |
| ASRX | | | INH | 47 57 | | 3 | | | | | |
| ASR opr | | b7 b0 | IX1 | 67 | ff | 6 | | | | | |
| ASR opr | | | IX | 77 | | 5 | | | | | |
| BCC rel | Branch if carry bit clear | ?C=0 | REL | 24 | rr | 3 | - | - | - | _ | - |
| BCLR n opr | Clear bit n | Mn ← 0 | DIR (b0) | 11 | dd | 5 | _ | - | - | - | |
| | | | DIR (b1) | 13 | dd | 5 | | | | | |
| | | | DIR (b2) | 15 | dd | 5 | | | | | |
| | | | DIR (b3) | 17 | dd | 5 | | | | | |
| | | | DIR (b4) | 19 | dd | 5 | | | | | |
| | | | DIR (b5) | 1B | dd | 5 | | | | | |
| | | | DIR (b6) | 1D | dd | 5 | | | | | |
| | | | DIR (b7) | 1F | dd | 5 | | | | | |
| BCS rel | Branch if carry bit set (Same as BLO) | ?C=1 | REL | 25 | rr | 3 | - | - | - | - | - |
| BEQ rel | Branch if equal | ?Z=1 | REL | 27 | rr | 3 | - | - | - | - | - |
| BHCC rel | Branch if half carry bit clear | ?H=0 | REL | 28 | rr | 3 | - | - | - | - | - |
| BHCS rel | Branch if half carry bit set | ?H=1 | REL | 29 | rr | 3 | - | - | - | - | +_ |
| BHI rel | Branch if higher | ?C+Z=0 | REL | 22 | rr | 3 | - | - | - | _ | - |
| BHS rel | Branch if higher or same | ?C=0 | REL | 24 | rr | 3 | - | - | _ | _ | - |
| BIH rel | Branch if IRQ pin high | ? IRQ = 1 | REL | 2F | rr | 3 | - | - | - | - | - |
| BIL rel | Branch if IRQ pin low | ? IRQ = 0 | REL | 2E | rr | 3 | - | _ | - | _ | - |
| BIT rel | Bit test accumulator with memory | (A) • (M) | IMM | A5 | ii | 2 | | | | | |
| DITIE | Bit lest accumulator with memory | (A) • (W) | DIR | B5 | dd | 2 3 | - | - | \$ | \$ | - |
| | | | EXT | C5 | hh II | | | | | | |
| | | | IX2 | D5 | ee ff | 4 5 | | | | | |
| | | | IX2 IX1 | E5 | ff | 5 4 | | | | | |
| | | | | F5 | l'' | 4 | | | | | |
| BLO rel | Branch if lower (Same as BCS) | ?C=1 | REL | 25 | rr | 3 | | - | - | _ | - |
| BLS rel | Branch if lower or same | ?C+Z=1 | REL | 23 | rr | 3 | | \vdash | | _ | 1 |
| BLS lei BMC rel | Branch if interrupt mask clear | ?I=0 | REL | 23 2C | rr | 3 | - | - | - | - | - |
| BMC rel | Branch if minus | ? N = 1 | REL | 20 2B | rr | 3 | - | - | - | - | 1 |
| BMS rel | Branch if interrupt mask set | ?1=0 | REL | 2D | rr | 3 | - | Ē | H | _ | |
| BNE rel | Branch if not equal | ?Z=0 | REL | 20 | | 3 | | <u> </u> | - | - | Ē |
| BPL rel | Branch if plus | ? N = 0 | | | rr | 3 | - | - | - | | |
| | | : IN = U | REL | 2A | rr | 3 | - | - | - | - | 1 - 1 |

Table 12-12. Instruction Set (Sheet 1 of 4) Freescale Semiconductor, Inc.

MOTOROLA 12-14

Semiconductor, Inc.

Freescale

INSTRUCTION SET

MC68HC05P6

Table 12=12-esetate isenit officie top, the.

| Source Form(s) | Operation | Description | Addressing Mode for | | e Coding ecimal) | Cycles | | | ndit Code | | |
|-------------------|------------------------------------|---|------------------------|----------|---------------------|--------|---|----------|--------------|----------|------------------|
| | | | Operand | Opcode | Operand | - | н | I | N | Z | C |
| BRA rel | Branch always | ?1=1 | REL | 20 | rr | 3 | - | - | - | _ | - |
| BRCLR n opr rel | | ? Mn = 0 | DIR (b0) | 01 | dd rr | 5 | | - | _ | - | 1 |
| | | | DIR (b1) | 03 | dd rr | 5 | | | | | |
| | | | DIR (b2) | 05 | dd rr | 5 | | | | | |
| | | | DIR (b3) | 07 | dd rr | 5 | | | | | |
| | | | DIR (b4) | 09 | dd rr | 5 | | | | | |
| | | | DIR (b5) | 0B | dd rr | 5 | | | | | |
| | | | DIR (b6) | 0D | dd rr | 5 | | | | | |
| | | | DIR (67) | 0F | dd rr | 5 | | | | | |
| BRN rel | Branch never | ?1=0 | REL | 21 | rr | 3 | - | - | - | _ | - |
| | Branch if bit n set | ? Mn = 1 | DIR (b0) | 00 | dd rr | 5 | - | _ | - | - | Î |
| Brider in oprior | | | DIR (b1) | 02 | dd rr | 5 | | | | | |
| | | | DIR (b2) | 04 | dd rr | 5 | | | | | |
| | | | DIR (b3) | 06 | dd rr | 5 | | | | | |
| | | | DIR (b4) | 08 | dd rr | 5 | | | | | |
| | | | DIR (b5) | 0A | dd rr | 5 | | | | | |
| | | | DIR (b5) DIR(b6) | 00 | dd rr | 5 | | | | | |
| | | | DIR (67) | 0C 0E | dd rr | 5 | | | | | |
| DEET D OFF | Sot hit n | Mn ← 1 | DIR (07) | 10 | dd | 5 | _ | - | - | _ | ╂───┤ |
| BSET n opr | Set bit n | | DIR (60) DIR (61) | 10 | dd | 5 | | - | - | - | 1-1 |
| | | | 1 | 12 | dd | 5 | | | | | |
| | | | DIR (b2) | 14 | dd | 5 | | | | | |
| | | | DIR (b3) | 18 | dd | 5 | | | | | |
| | | | DIR (b4) | | 1 | | | | | | |
| | | | DIR (b5) | 1A | dd | 5 | | | | | |
| | | | DIR (b6) | 1C | dd | 5 | | | | | |
| | l | | DIR (b7) | 1E | dd | 5 | | | | | |
| BSR rel | Branch to subroutine | $\begin{array}{l} PC \leftarrow (PC) + 2; push (PCL) \\ SP \leftarrow (SP) - 1; push (PCH) \\ SP \leftarrow (SP) - 1 \\ PC \leftarrow (PC) + rel \end{array}$ | REL | AD | rr | 6 | - | - | - | - | - |
| CLC | Clear carry bit | C ← 0 | INH | 98 | | 2 | - | - | - | - | 0 |
| CLI | Clear interrupt mask | 1←0 | INH | 9A | | 2 | - | 0 | - | - | - |
| CLR opr | Clear register | M ← \$00 | DIR | 3F | dd | 5 | - | _ | 0 | 1 | - |
| CLRA | | A ← \$00 | INH | 4F | | 3 | | | | | |
| CLRX | | X ← \$00 M ← \$00 | INH | 5F | | 3 | | | | | |
| CLR opr | | M ← \$00 | IX1 | 6F | ff | 6 | | | | | |
| CLR opr | | | IX | 7F | | 5 | | | | | |
| CMP opr | Compare accumulator with | $(\Delta) = (M)$ | IMM | A1 | ii | 2 | _ | - | \$ | \$ | ¢ |
| | memory | (~) - (m) | DIR | B1 | dd | 3 | | | | * | |
| | _ | | EXT | C1 | hh II | 4 | | | | | |
| | | | IX2 | D1 | ee ff | 5 | | | | | |
| | | | IX1 | E1 | ff | 4 | | | | | |
| | | | | F1 | '' | 3 | | | | | |
| COM opr | Complement memory or | $M \leftarrow \overline{M} = \$FF - (M)$ | DIR | 33 | dd | 5 | | | \$ | | $\left \right $ |
| COM opr COMA | Complement memory or register | $A \leftarrow \overline{A} = \$FF - (A)$ | INH | 33 43 | uu l | 5 | - | - | ♥ | \$ | 1 |
| | (one's complement) | $X \leftarrow \overline{X} = $ \$FF – (X) | | | | | | | | | |
| COMX | | $M \leftarrow \overline{M} = \$FF - (M)$ | INH | 53 | | 3 | | | | | |
| COM opr | | $M \leftarrow \overline{M} = FF - (M)$ | IX1 | 63 70 | ff | 6 | | | | | |
| COM opr | | 00 40 | IX | 73 | <u></u> | 5 | ļ | <u> </u> | | <u> </u> | ┝ |
| CPX opr | Compare index register with memory | (X) – (M) | IMM | A3 | ii | 2 | - | - | \$ | \$ | \$ |
| | | | DIR | B3 | dd | 3 | | | | | |
| | | | EXT | C3 | hh II | 4 | | | | | |
| | | | IX2 | D3 | ee ff | 5 | | | | | |
| | | | IX1 | E3 | ff | 4 | | | | | |
| | | | IX | F3 | | 3 | | | | | |
| DEC opr | Decrement | $M \leftarrow (M) - 1$ | DIR | 3A | dd | 5 | - | - | \$ | \$ | - |
| DECA | | $ \begin{array}{l} A \leftarrow (A) - 1 \\ X \leftarrow (X) - 1 \end{array} $ | INH | 4A | | 3 | | | | | 1 |
| DECX | | $M \leftarrow (M) - 1$ | INH | 5A | | 3 | | | | | |
| | 1 | | 1 | | 1 | | I | | | | 1 |
| DEC opr | | M ←(M) – 1 | IX1 | 6A | ff | 6 | i | | | | |

INSTRUCTION SET

MOTOROLA 12-15

Table 12-12. Instruction Set (Sheet 3 of 4) Freescale Semiconductor, Inc.

| Source Form(s) | Operation | Description | Addressing Mode for | | e Coding lecimal) | Cycles | | | ndit Code | | |
|-------------------|--|--|------------------------|--------|----------------------|--------|---|---|--------------|----|----------|
| | | | Operand | Opcode | Operand | | н | 1 | N | Z | C |
| EOR opr | Exclusive OR accumulator with | $A \leftarrow (A) \oplus (M)$ | IMM | A8 | 11 | 2 | _ | _ | t | \$ | - |
| Lontopi | memory | | DIR | B8 | dd | 3 | | | ľ | Ť | |
| | - | | EXT | C8 | hh II | 4 | | | | | |
| | | | IX2 | D8 | ee ff | 5 | | | | | |
| | | | | | | | | | | | |
| | | | IX1 | E8 | ff | 4 | | | | | |
| | | | IX | F8 | | 3 | | | | | <u> </u> |
| INC opr | Increment memory or register | $M \leftarrow (M) + 1$ $A \leftarrow (A) + 1$ | DIR | 3C | dd | 5 | - | - | \$ | \$ | - |
| INCA | | $X \leftarrow (X) + 1$ | INH | 4C | | 3 | | | | | |
| INCX | | M ← (M) + 1 | INH | 5C | | 3 | | | | | |
| INC opr | | M ← (M) + 1 | IX1 | 6C | ff | 6 | | | 1 | | |
| INC opr | | | IX | 7C | | 5 | | | | | |
| JMP opr | Unconditional jump | PC ← jump address | DIR | BC | dd | 2 | - | - | - | - | - |
| | | | EXT | cc | hh li | 3 | | | | | |
| | | | IX2 | DC | ee ff | 4 | | | | | |
| | | | IX1 | EC | ff | 3 | | | | | |
| | | | IX | FC | [| 2 | | | | | |
| ISP on | lump to subrouting | $PC \leftarrow (PC) + n (n = 1, 2, or 3)$ | DIR | BD | dd | 5 | - | _ | - | - | - |
| JSR opr | Jump to subroutine | Push (PCL); SP \leftarrow (SP) – 1 | EXT | CD | hh II | | - | - | - | - | - |
| | | Push (PCH); SP \leftarrow (SP) – 1 | | | 1 | 6 | | | | | |
| | | PC | IX2 | DD | ee ff | 7 | | | | | |
| | | | IX1 | ED | ff | 6 | | | | | |
| | | | IX | FD | | 5 | | | | | |
| LDA opr | Load accumulator from | A ← (M) | IMM | A6 | 11 | 2 | - | - | \$ | \$ | - |
| | memory | | DIR | B6 | dd | 3 | | | | | |
| | | | EXT | C6 | hh II | 4 | | | | | |
| | | | IX2 | D6 | ee ff | 5 | | | | | |
| | | | IX1 | E6 | ff | 4 | | | | | |
| | | | IX | F6 | | 3 | | | | | |
| LDX opr | Load index register from | $X \leftarrow (M)$ | IMM | AE | 111 | 2 | _ | _ | Ĵ | \$ | - |
| CD/C Op! | memory | | DIR | BE | dd | 3 | | | | • | |
| | - | | EXT | CE | hh II | 4 | | | | | |
| | | | IX2 | DE | ee ff | 5 | | | 1 | | |
| | | | | EE | ff | | | | | | |
| | | | IX1 | | 11 | 4 | | | | | |
| | | | IX | FE | | 3 | | | | | |
| LSL opr | Logical shift left (Same as ASL) | | DIR | 38 | dd | 5 | - | - | \$ | \$ | \$ |
| LSLA | | | INH | 48 | | 3 | | | | | |
| LSLX | | | INH | 58 | | 3 | | | | | ļ |
| LSL opr | | | IX1 | 68 | ff | 6 | | | | | |
| LSL opr | | | IX | 78 | | 5 | | | | | |
| LSR opr | Logical shift right | | DIR | 34 | dd | 5 | - | - | 0 | \$ | Ĵ |
| LSRA | | | INH | 44 | | 3 | | | | | |
| LSRX | | ⁰→⊑тттты | INH | 54 | | 3 | | | | | |
| LSR opr | | 67 60 | IX1 | 64 | ff | 6 | | | | | |
| LSR opr | | | IX | 74 | | 5 | | | | | |
| MUL | Unsigned multiply | $X : A \leftarrow (X) \times (A)$ | INH | 42 | | 11 | 0 | | | | 0 |
| | | | | | l | | 0 | - | - | - | |
| NEG opr | Negate memory or register (two's complement) | $M \leftarrow -(M) = $00 - (M)$ $A \leftarrow -(A) = $00 - (A)$ | DIR | 30 | dd | 5 | - | - | \$ | \$ | \$ |
| NEGA | | $X \leftarrow -(X) = $00 - (X)$ | INH | 40 | | 3 | | | | | |
| NEGX | | M ← –(M) = \$00 – (M) | INH | 50 | | 3 | | | | | |
| NEG opr | | $M \leftarrow -(M) = \$00 - (M)$ | IX1 | 60 | ff | 6 | | | | | |
| NEG opr | | | IX | 70 | | 5 | | | | | |
| NOP | No operation | | INH | 9D | | 2 | - | - | - | - | - |
| ORA opr | Inclusive OR accumulator with | $A \leftarrow (A) + (M)$ | IMM | AA | ii | 2 | - | _ | \$ | Ĵ | - |
| - P' | memory | | DIR | BA | dd | 3 | | | Ĩ | | |
| | | | EXT | CA | hh II | 4 | | | | | |
| | | | IX2 | DA | ee ff | 5 | | | | | |
| | | | IX1 | EA | ff | 4 | | | | | |
| | | | | | 1" | | | | | | |
| | | | IX | FA | l | 3 | | | <u> </u> | | - |
| ROL opr | Rotate left through carry | | DIR | 39 | dd | 5 | | - | \$ | \$ | \$ |
| ROLA | | | INH | 49 | | 3 | | | | | |
| ROLX | | | INH | 59 | | 3 | | | | | |
| | | 1 | 1.5.7.4 | | 1 | | | | I 1 | | 1 |
| ROL opr | | | IX1 IX | 69 | ff | 6 | | | | | 1 |

MOTOROLA 12-16

INSTRUCTION SET

MC68HC05P6

Table 12 12 estable Sense ditte top, the.

| Source | Operation | Description | Addressing Mode for | | o Coding ecimal) | Cycles | | | ndit Cod | | |
|---------|---|--|------------------------|----------|---------------------|--------|----|-----|-------------|----------|------------|
| Form(s) | Operation | Description | Operand | Opcode | Operand | Cycles | н | | N | Z | C |
| ROR opr | Rotate right through carry | | DIR | 36 | dd | 5 | | - | 1 1 | 1 | 1 |
| RORA | notate fight through carry | | INH | 46 | uu | 3 | - | - | • | * | + |
| RORX | | | INH | 56 | | 3 | | | | | |
| ROR opr | | b/ D0 | IX1 | 66 | ff | 6 | | | | | |
| ROR opr | | | IX | 76 | | 5 | | | | [| |
| RSP | Reset stack pointer | SP ← \$00FF | INH | 9C | | 2 | - | _ | - | - | <u>† –</u> |
| RTI | Return from interrupt | $SP \leftarrow (SP) + 1; pull (CCR)$ | INH | 80 | | 9 | | Fro | m St | lack | L |
| | | $\begin{array}{l} SP \leftarrow (SP) + 1; \mbox{ pull } (A) \\ SP \leftarrow (SP) + 1; \mbox{ pull } (X) \\ SP \leftarrow (SP) + 1; \mbox{ pull } (PCH) \\ SP \leftarrow (SP) + 1; \mbox{ pull } (PCL) \end{array}$ | | | | | \$ | \$ | \$ | \$ | \$ |
| RTS | Return from subroutine | $SP \leftarrow (SP) + 1; pull (PCH)$ $SP \leftarrow (SP) + 1; pull (PCL)$ | INH | 81 | | 6 | - | - | - | - | - |
| SBC opr | Subtract memory and carry bit | $A \leftarrow (A) - (M) - C$ | ІММ | A2 | ii | 2 | - | - | \$ | \$ | \$ |
| | from accumulator | | DIR | B2 | dd | 3 | | | | | |
| | |] | EXT | C2 | hh ll | 4 | | | | | |
| | | | IX2 | D2 | ee ff | 5 | | | | | |
| | | | IX1 | E2 | ff | 4 | | | | 1 | |
| | | | IX | F2 | | 3 | | | | | |
| SEC | Set carry bit | C ← 1 | INH | 99 | | 2 | - | - | - | - | 1 |
| SEI | Set interrupt mask | ←1 | INH | 9B | | 2 | - | 1 | - | _ | <u> -</u> |
| STA opr | Store accumulator in memory | (A) → M | DIR | B7 | dd | 4 | - | - | \$ | \$ | - |
| | | | EXT | C7 | hh ll | 5 | | | | | 1 |
| | | 1 | IX2 | D7 | ee ff | 6 | | | | | 1 |
| | | | IX1 | E7 | ff | 5 | | | | |] |
| 0700 | | | IX INH | F7 | | 4 | | | | <u> </u> | |
| STOP | Enable IRQ; stop oscillator | M ← (X) | | 8E | | | - | 0 | - | - | <u> -</u> |
| STX opr | Store index register in memory | $M \leftarrow (\lambda)$ | DIR EXT | BF CF | dd hh ll | 4 5 | - | - | \$ | \$ | - |
| | | 1 | IX2 | DF | ee ff | 6 | | | | | |
| | | | IX1 | EF | ff | 5 | | | | | |
| | | | | FF | | 4 | | | | | |
| SUB opr | Subtract memory from | $A \leftarrow (A) - (M)$ | ІММ | A0 | ii | 2 | - | _ | \$ | ‡ | 1 |
| 000 001 | accumulator | | DIR | BO | dd | 3 | | | | | 1 |
| | | | EXT | CO | hh II | 4 | | | | | |
| | | | IX2 | D0 | ee ff | 5 | | | | | |
| | | | IX1 | E0 | ff | 4 | | | | | |
| | | 1 | IX | F0 | | 3 | 1 | | 1 | | 1 |
| SWI | Software interrupt | $\begin{array}{l} PC \leftarrow (PC) + 1; push (PCL) \\ SP \leftarrow (SP) - 1; push (PCH) \\ SP \leftarrow (SP) - 1; push (X) \\ SP \leftarrow (SP) - 1; push (A) \\ SP \leftarrow (SP) - 1; push (ACCR) \\ SP \leftarrow (SP) - 1; l \leftarrow 1 \\ PCH \leftarrow Interrupt vector hi byte \\ PCL \leftarrow Int. vector low byte \end{array}$ | | 83 | | 10 | - | 1 | - | - | - |
| TAX | Transfer accumulator to index register | $X \leftarrow (A)$ | INH | 97 | | 2 | - | - | - | - | - |
| TST opr | Test memory or register for | (M) - \$00 | DIR | 3D | dd | 4 | - | - | \$ | \$ | - |
| TSTA | negative or zero | | INH | 4D | | 3 | | | | | 1 |
| тѕтх | | | INH | 5D | | 3 | | | | | |
| TST opr | 1 | | IX1 | 6D | ff | 5 | | | | | 1 |
| TST opr | | | IX | 7D | | 4 | | | | | |
| ТХА | Transfer index register to accumulator | $A \leftarrow (X)$ | INH | 9F | | 2 | - | - | - | - | - |
| WAIT | Enable interrupts; halt CPU | | INH | 8F | | 2 | - | 0 | - | - | - |

MC68HC05P6

INSTRUCTION SET

12.4 Opcode Map

Freescale Semiconductor, Inc.

Table 12-13 is an opcode map of the M68HC05 instruction set.

| | | н го | 0000 | 1 0001 | 2 0010 | 3 0011 | 4 0100 | 5 0101 | 6 0110 | 7 0111 | 8 1000 | 9 1001 | A 1010 | B 1011 | C C | D 101 | E 110 | 1111 F | | simal |
|-------------------|-----|--------------|-------------------------|-----------------------|---------------------------|------------------|---------------------------|---------------------------|---------------------------|-------------------------|---------------------------|-------------------|-------------------------|------------------|-------------------------|------------------|---------------------------|---------------------------|------------------------------------|--|
| | XI | F 1111 | | CMP 3 | sBC 3 | CPX 3 | AND 3 | BIT 3 1 IX | + LDA 3 | STA 4 | EOR 3 | ADC 3 | ORA 3 | ADD ³ | JMP 2 1 IX 1 | JSR 5 1 IX 1 | 1 LDX 1 | stx ⁴ | | yte of Opcode in Hexadecimal yte of Opcode in Binary Low Byte of Opcode in Hexadecimal Low Byte of Opcode in Binary |
| | 1X1 | E 1110 | SUB 2 IX1 | CMP 4 2 IX1 | SBC 4 2 IX1 | N 1 | N | BIT 2 IX1 | 2 LDA 2 IX1 | N | N | N 1 | ORA 2 IX1 | 2 | 3 JMP 2 IX1 | JSR 2 IX1 | 2 LDX 2 IX1 | N | | Byte of Opcode in Hexadecimal Byte of Opcode in Binary Low Byte of Opcode in Hexad |
| Register/Memory | 1X2 | D 1101 | 5 SUB 3 IX2 | 5 CMP 3 IX2 | sBC 3 IX2 | 3 CPX 5 3 IX2 | ിത | BIT 3 IX2 | LDA 3 IX2 | STA 3 IX2 | 6 | ADC 3 IX2 | 6 | 9 | JMP 3 IX2 | JSR 3 IX2 | 3 LDX 3 IX2 | е | | yte of Opc yte of Opc Low Byte |
| Register | EXT | 1100 1100 | SUB 3 EXT | CMP 4 3 EXT | SBC 4 3 EXT | CPX 4 3 EXT | 9 | BIT 3 EXT | 3 LDA 3 EXT | 0 | | ADC 3 EXT | ORA 3 EXT | 6 | JMP 3 EXT | JSR 3 EXT | 9 | STX 3 EXT | IND | High 3 0000 XI |
| | DIR | 1011 | SUB 2 DIR | CMP 3 CMP 2 DIR | sBC 3 2 DIR | CPX 3 2 DIR | AND 3 2 DIR | BIT 2 DIR | 2 LDA 2 DIR | N | N N | ADC 3 2 DIR | ORA 2 DIR | 5 | JMP 2 DIR | 6 JSR L 2 DIR | ~ | STX 2 DIR | LEGEND | 1111 1111 1111 1111 |
| • | WWI | 1010 | SUB 2 IMM | CMP 2 2 IMM | SBC 2 2 IMM | CPX 2 2 IMM | AND 2 MM | BIT 2 1 IMM | LDA 2 IMM | | EOR 2 | ADC 2 | 2 ORA I 2 IMM | 2 | 0 | BSR 2 RE | LDX 2 IMM | 0 | | Number of Cycles Opcode Mnemoric |
| Control | HNI | 9 1001 | | 9 1 | | 0 - | | | | TAX 1 INH | CLC 2 CLC 2 | sec 2 1 NH | CLI 2 CLI 2 | SEI 2 1 SEI 2 | RSP 2 1 INH | NOP 2 1 INH | 4 2 | TXA TXA I I INH | | Numb Opcodo |
| . S | HNI | 8 1000 | ATI 1 | RTS 1 INH | | 5 SWI X 1 INH | 2 2 | | 5 X | | | | | | | X 4 | STOP 1 INH | 5 WAIT 2 K 1 INH | | mher of A |
| | XI | 0111 | | | | | LSR | | ROR | ASR 5 | LSL/ASL | BOL 5 | DEC 5 | | 6 INC 5 | TST 1 | | | | Z |
| Write | 1X1 | 6 0110 | NEG 6 2 IX1 | | | 2 COM | 3 LSR 6 | | 3 ROR 6 4 2 IX1 | 2 | 5 | B ROL 6 | N | | | т ST 2 IX | | 3 CLR 6 4 2 LX1 | | |
| Read-Modify-Write | HNI | 5 0101 | т <u>з</u> | | | 3 COMX | LSRX 1 1 INH | | | ASRX ASRX | HNI 1 TSLX 8 | 3 ROLX H 1 INH | DECX | | 3 INCX 3 | TSTX 1 TSTX | | | | |
| Rea | HNI | 0100 | | | MUL 11 | - | 5 LSRA 1 LSRA | | RORA INI | | E LSLA | ROLA IN | 5 DECA 3 DECA | | INCA INCA | TSTA | | CLRA 1 INI | | No Offset 8-Bit Offset 16-Bit Offset |
| | DIR | 3 0011 | 2 DI | E | 8 | 3 COM 5 2 DIR | LSR 2 DIR | | S | ASR 2 ASR | 20 | B ROL | N N | 3 | | 3 TST 4 | . 3 | | G MODES | ive (ed, No Offset (ed, 8-Bit Offs (ed, 16-Bit Off |
| Branch | REL | 2 0010 | 8 BRA 8 2 REL | s BRN REL | BHI 3 BHI 2 REL | BLS BLS | BCC 3 BCC 3 3 2 REL | BCS 8 BCS | BNE 2 BNE | BEQ 2 BEQ | BHCC BHCC | BHCS 1 2 REL | 5 BPL 3 2 REL | 5 | BMC 3 BMC 3 BMC | BMS BMS | a BIL 3 BIL 3 Z REL | N | DDRESSIN | :L Relative Indexed, 1 Indexed, 2 Indexed, |
| Bit Manipulation | DIR | 0001 | BSET0 BSET0 BSET0 | BCLR0 3 2 DIR | BSET1 BSET1 3 2 DIR | BCLR1 3 2 DIR | BSET2 BSET2 3 2 DIR | BCLR2 BCLR2 3 2 DIR | BSET3 BSET3 3 2 DIR | BCLR3 BCLR3 2 DIR | BSET4 BSET4 3 2 DIR | BCLR4 3 2 DIR | BSET5 BSET5 BSET5 | BCLR5 BCLR5 | BSET6 BSET6 BSET6 | BCLR6 BCLR6 | BSET7 BSET7 A 2 DIR | BCLR7 BCLR7 3 2 DIR | ABBREVIATIONS FOR ADDRESSING MODES | ate IX ate IX IX1 ed IX2 |
| Bit Mar | 1 | 0000 | BRSET0 3 DIR | BRCLR0 3 DIR | BRSET1 3 DIR | BRCLR1 3 DIR | BRSET2 3 DIR | BRCLR2 3 DIR | BRSET3 3 DIR | BRCLR3 3 DIR | BRSET4 3 DIR | BRCLR4 3 DIR | BRSET5 3 DIR | BRCLR5 3 DIR | BRSET6 3 DIR | BRCLR6 3 DIR | BRSET7 3 DIR | | REVIATION | Inherent Immediate Direct Extended |
| | | Lo H | 0000 | 10001 | 2 0010 | 3 0011 | 40100 | 50101 | 6 0110 | 7 0111 | 8 1000 | 9 1001 | A 1010 | B 1011 | C 1100 | D 1101 | E 1110 | н 111 11 | ABBF | INH IMM DIR EXT |
| N | 10 | TOF | ROLA | 4 | | | | | I | NST | RUC | CIT | N S | ET | | | | | | MC68 |

Freescale Semiconductor, Inc. Table 12-13. Opcode Map

MC68HC05P6

For More Information On This Product, Go to: www.freescale.com

12-18

SECTION 13 ELECTRICAL SPECIFICATIONS

This section contains MCU electrical specifications and timing information.

13.1 Maximum Ratings

The MCU contains circuitry that protects the inputs against damage from high static voltages; however, do not apply voltages higher than those shown in Table 13-1. Keep V_{IN} and V_{OUT} within the range $V_{SS} \leq (V_{IN} \text{ or } V_{OUT}) \leq V_{DD}$. Connect unused inputs to the appropriate logic level, either V_{SS} or V_{DD} .

| Rating | Symbol | Value | Unit |
|--|------------------|--|----------|
| Supply Voltage | V _{DD} | -0.3 to +7.0 | V |
| Input Voltage | VIN | $V_{SS} - 0.3$ to $V_{DD} + 0.3$ | V |
| Current Drain per Pin (Excluding V_{DD} and V_{SS}) | I | 25 | mA |
| Operating Temperature Range MC68HC05P6P, DW, S (Standard) MC68HC05P6CP, CDW, CS (Extended) MC68HC05P6VP, VDW, VS (Automotive) MC68HC05P6MP, MDW, MS (Automotive) | Ta | 0 to +70 -40 to +85 -40 to +105 -40 to +125 | °C |
| Storage Temperature Range | T _{STG} | -65 to +150 | ℃ |

| Fable 13 | -1. | Maximum | Ratings |
|----------|-----|---------|---------|
|----------|-----|---------|---------|

NOTES:

1. P = Plastic dual in-line package (PDIP)

2. DW = Small outline integrated circuit (SOIC)

3. S = Ceramic dual in-line package (Cerdip)

4. C = Extended temperature range (-40 to +85 °C)

5. V = Automotive temperature range (-40 to +105 °C)

6. M = Automotive temperature range (-40 to +125 °C)

13.2 Thermal Characteristics

| | Table | 13-2. | Thermal | Resistance |
|--|-------|-------|---------|------------|
|--|-------|-------|---------|------------|

| Characteristic | Symbol | Value | Unit |
|---------------------------------------|--------|----------|------|
| Thermal Resistance Plastic SOIC | Reja | 60 60 | °C∕W |

MC68HC05P6

ELECTRICAL SPECIFICATIONS

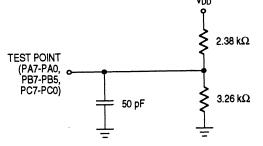


Figure 13-1. Test Load

13.3 Power Considerations

The average chip junction temperature, T_J, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \times \theta_{JA})$$
(1)

where:

For most applications $P_{I/O} \ll P_{INT}$ and can be neglected. The following is an approximate relationship between P_D and T_J (if $P_{I/O}$ is neglected):

$$P_D = K \div (T_J + 273 \ ^{\circ}C)$$
 (2)

Solving equations (1) and (2) for K gives:

$$K = P_A \times (T_A + 273 \text{ °C}) + R_{\theta JA} \times P_D$$
(3)

where K is a constant pertaining to the particular part. K can be determined from equation (3) by measuring P_D (at equilibrium) for a known T_A . Using this value of K, the values of P_D and T_J can be obtained by solving equations (1) and (2) iteratively for any value of T_A .

MOTOROLA 13-2 ELECTRICAL SPECIFICATIONS

MC68HC05P6

| Characteristic | Symbol | Min | Тур | Max | Unit | |
|--|-------------------------|---------------------------|-----------------------------|-------------------------------|----------------------|--|
| Output Voltage $I_{LOAD} = 10.0 \ \mu A$ $I_{LOAD} = -10.0 \ \mu A$ | Vol Voн | V _{DD} – 0.1 | _ | 0.1 | v v | |
| Output High Voltage (I _{LOAD} = -0.8 mA) PA7-PA0, PB7/SCK-PB5/SDO, PC7/V _{RH} -PC3/AN3, PC2-PC0, PD5, TCMP | V _{OH} | V _{DD} - 0.8 | | | v | |
| Output Low Voltage (I _{LOAD} = 1.6 mA) PA7–PA0, PB7/SCK–PB5/SDO, PC7/V _{RH} –PC3/AN3, PC2–PC0, PD5, TCMP | Vol | | | 0.4 | v | |
| Input High Voltage PA7–PA0, PB7/SCK–PB5/SDO, P <u>C7/V_{RH}–</u> PC3/AN3, PC2–PC0, PD5, PD7/TCAP, IRQ, RESET, OSC1 | VIH | 0.7 × V _{DD} | _ | V _{DD} | v | |
| Input Low Voltage PA7–PA0, PB7/SCK–PB5/SDO, PC7/V _{RH} –PC3/AN3, PC2–PC0, PD5, PD7/TCAP, IRQ, RESET, OSC1 | ViL | V _{SS} | _ | $0.2 \times V_{DD}$ | v | |
| Supply Current (NOTES 3–6) RUN WAIT (A/D Converter On) WAIT (A/D Converter Off) STOP 25 °C 0 to 70°C (Standard) -40 to 125 °C | IDD | | 3.6 1.8 1.3 2 — | 7.0 4.0 2.0 30 50 | mA mA mA μA | |
| I/O Ports Hi-Z Leakage Current PA7–PA0, PB7–PB5, PC7–PC0, PD5 | Ι _Ι | | | 100 ±10 | μΑ μΑ | |
| A/D Ports Hi-Z Leakage Current | loz | | | ±1 | μ Α | |
| Input Current RESET, IRQ, OSC1, PD7/TCAP | lin | | | ±1 | μA | |
| Capacitance <u>Ports (As Input or Output)</u> RESET, IRQ | Cout C _{IN} | | | 12 8 | pF pF | |

| Table | 13-3. | DC | Electrical | Characteristics | (V _{DD} | = 5.0 | Vdc) |
|-------|-------|----|------------|-----------------|------------------|-------|------|
|-------|-------|----|------------|-----------------|------------------|-------|------|

NOTES:

.

1. V_{DD} = 5.0 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H , unless otherwise noted.

2. Typical values at midpoint of voltage range, 25°C only.

3. RUN (operating) I_{DD} and WAIT I_{DD} measured using external square wave clock source (f_{OSC} = 4.2 MHz); all inputs 0.2 V from rail; no dc loads; less than 50 pF on all outputs; C_L = 20 pF on OSC2.

4. WAIT I_{DD} and STOP I_{DD}: all ports configured as inputs; $V_{IL} = 0.2 V$; $V_{IH} = V_{DD} - 0.2 V$.

5. STOP I_{DD} measured with OSC1 = VSS.

6. WAIT IDD is affected linearly by the OSC2 capacitance.

MC68HC05P6

ELECTRICAL SPECIFICATIONS

Freescale Semiconductor, Inc. 13.5 DC Electrical Characteristics (V_{DD} = 3.3 Vdc)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|-----------------|---------------------------|-------------------------------|-------------------------------------|----------------------------|
| Output Voltage (I _{LOAD} ≤ 10.0 μA) | Vol Voн | V _{DD} – 0.1 | | 0.1 | v |
| Output High Voltage (I _{LOAD} = -0.2 mA) PA7-PA0, PB7/SCK-PB5/SDO, PC7/V _{RH} -PC3/AN3, PC2-PC0, PD5, TCMP | V _{OH} | V _{DD} – 0.3 | _ | | v |
| Output Low Voltage (I _{LOAD} = 0.4 mA) PA7–PA0, PB7/SCK–PB5/SDO, PC7/V _{RH} –PC3/AN3, PC2–PC0, PD5, TCMP | Vol | _ | | 0.3 | v |
| Input High Voltage PA7–PA0, PB7/SCK–PB5/SDO, P <u>C7/V_{RH}–</u> PC3/AN3, PC2–PC0, PD5, PD7/TCAP, IRQ, RESET, OSC1 | Viн | $0.7 \times V_{DD}$ | | V _{DD} | v |
| Input Low Voltage PA7–PA0, PB7/SCK–PB5/SDO, PC7/V _{RH} –PC3/AN3, PC2–PC0, PD5, PD7/TCAP, IRQ, RESET, OSC1 | ViL | V _{SS} | _ | 0.2 × V _{DD} | v |
| Data-Retention Mode Supply Voltage | VRM | 2.0 | _ | _ | V |
| Supply Current (NOTES 3–6) RUN WAIT(A/D Converter On) WAIT (A/D Converter Off) STOP 25°C 0 to 70°C (Standard) -40 to +125 °C | Ισσ | | 1.6 0.9 0.4 1.0 — | 2.5 1.4 1.0 20 40 50 | mA mA mA μA μA |
| I/O Ports Hi-Z Leakage Current PA7–PA0, PB7/SCK–PB5/SDO, PC7/V _{RH} –PC3/AN3, PC2–PC0, PD5 | lι∟ | _ | | ±10 | μA |
| Input Current RESET, IRQ, OSC1, PD5, PD7/TCAP | lın | | | ±1 | μA |
| Capacitance Ports (As Input or Output) | Солт | | | 12 | pF |

Table 13-4. DC Electrical Characteristics ($V_{DD} = 3.3$ Vdc)

NOTES:

1. V_{DD} = 3.3 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H unless otherwise noted.

2. Typical values at midpoint of voltage range, 25°C only.

3. RUN (operating) I_{DD} and WAIT I_{DD} measured using external square wave clock source (f_{OSC} = 2.1 MHz); all inputs 0.2 V from rail; no dc loads; less than 50 pF on all outputs; C_L = 20 pF on OSC2.

CIN

4. WAIT I_{DD} and STOP I_{DD}: all ports configured as inputs; $V_{IL} = 0.2 V$, $V_{IH} = V_{DD} - 0.2 V$.

5. STOP I_{DD} measured with OSC1 = V_{SS}.

RESET, IRQ, PD5, PD7/TCAP

6. WAIT IDD is affected linearly by the OSC2 capacitance.

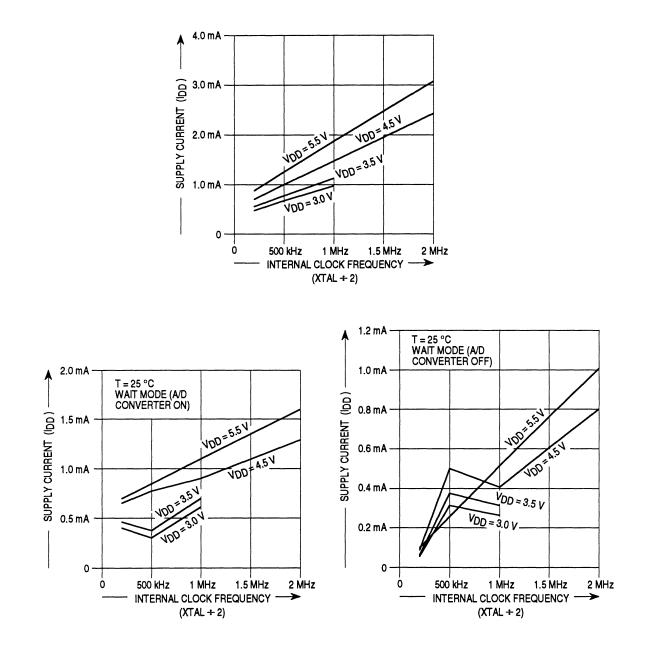
MOTOROLA 13-4

ELECTRICAL SPECIFICATIONS

MC68HC05P6

pF

8





Semiconductor, Inc.

Freescale

ELECTRICAL SPECIFICATIONS

MOTOROLA 13-5

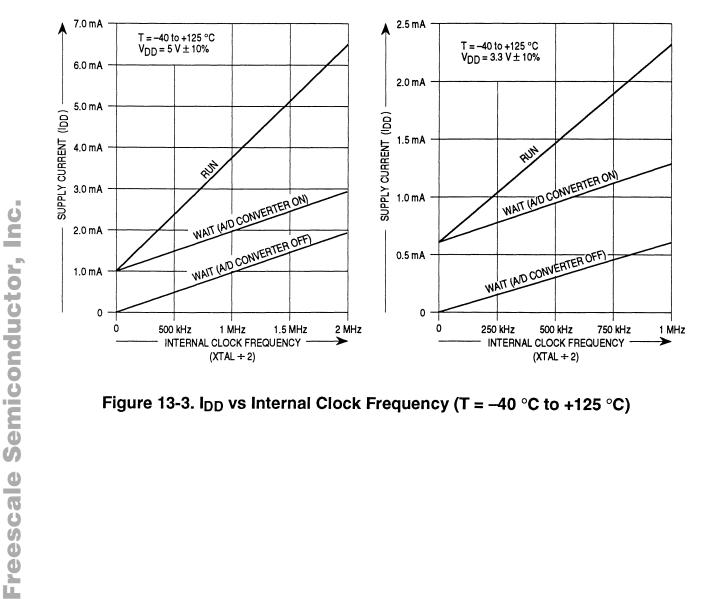


Figure 13-3. I_{DD} vs Internal Clock Frequency (T = -40 °C to +125 °C)

ELECTRICAL SPECIFICATIONS

MC68HC05P6

| Characteristic | Min | Max | Unit | |
|--|-------------------------------|-----------------|-----------------------|--|
| Resolution | 8 | 8 | Bit | |
| Absolute Accuracy (4.0 > V _{RH} > V _{DD}) (NOTE 2) | | ±1-1/2 | LSB | |
| Conversion Range (V _{RH} Pin) | V _{SS} | V _{DD} | V | |
| Conversion Time (Includes Sampling Time) External Clock (XTAL) Internal RC Oscillator (ADRC = 1) | 32 32 | 32 32 | t _{AD} μs | |
| Monotonicity | Inherent (Within Total Error) | | | |
| Zero Input Reading (V _{IN} = 0 V) | 00 | 01 | Hex | |
| Full-Scale Reading (V _{IN} = V _{RH}) | н Т | FF | Hex | |
| Sample Acquisition Time (NOTE 3) External Clock (XTAL) Internal RC Oscillator (ADRC) = 1 | 12 | 12 12 | t _{AD} μs | |
| Input Capacitance PC6/AN0, PC5/AN1, PC4/AN2, PC3/AN3 | | 12 | pF | |
| Analog Input Voltage | V _{SS} | V _{RH} | V | |
| Input Leakage (NOTE 5) PC6/AN0, PC5/AN1, PC4/AN2, PC3/AN3 V _{RH} | _ | ±1 ±1 | μΑ μΑ | |

Table 13-5. A/D Converter Characteristics

NOTES:

1. V_{DD} = 5.0 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H , unless otherwise noted.

2. A/D accuracy may decrease proportionately as V_{RH} is reduced below 4.0 V.

3. Source impedances greater than 10 kohm adversely affect internal RC charging time during input sampling.

4. $t_{AD} = t_{CYC}$ if clock source is MCU.

5. The external system error caused by input leakage current is approximately equal to the product of R source and input current.

MC68HC05P6

ELECTRICAL SPECIFICATIONS

| • • • = = / | | | | |
|-----------------|---|------------|---|--|
| Symbol | Min | Max | Unit | |
| fosc | dc | 4.2 4.2 | MHz MHz | |
| fop | dc | 2.1 2.1 | MHz MHz | |
| tcyc | 480 | - | ns | |
| toxov | | 100 | ms | |
| tilCH | | 100 | ms | |
| t _{RL} | 1.5 | _ | tcyc | |
| tRESL | 4.0 | | tcyc | |
| tilih | 125 | _ | ns | |
| tilil | (NOTE 3) | | tcyc | |
| toн, tol | 90 | | ns | |
| tRCON | | 5 | μs | |
| tadon | | 100 | μs | |
| | fosc fop tcyc toxov tilcH tRESL tilH trESL tilH tilLI toH, toL trCON | fosc | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | |

Table 13-6. Control Timing ($V_{DD} = 5.0$ Vdc)

NOTES:

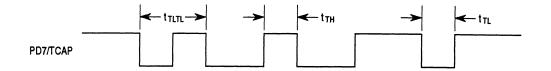
1. V_{DD} = 5.0 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H , unless otherwise noted.

2. Since a 2-bit prescaler in the timer must count four internal cycles (t_{CYC}), this is the limiting minimum factor in determining the timer resolution.

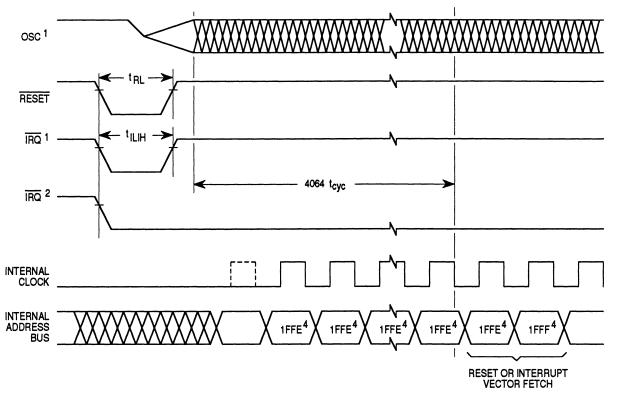
3. The minimum period t_{ILIL} should not be less than the number of cycle times it takes to execute the interrupt service routine plus 19 t_{CYC}.

MOTOROLA 13-8

ELECTRICAL SPECIFICATIONS







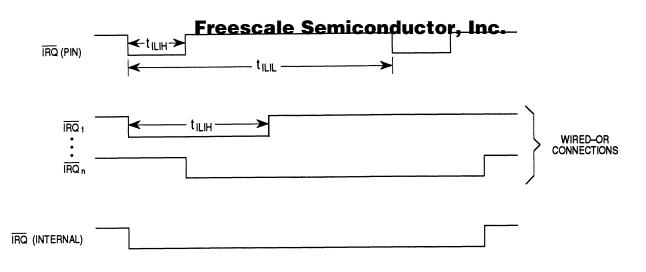
NOTES:

- 1. Represents the internal clocking of OSC1 pin.
- 2. External interrupt edge-triggered mask option.
- 3. External interrupt edge- and level-triggered mask option.
- 4. Reset vector shown for timing example.

Figure 13-5. STOP Recovery Timing

MC68HC05P6

ELECTRICAL SPECIFICATIONS





13.8 Control Timing (V_{DD} = 3.3 Vdc)

| Characteristic | Symbol | Min | Max | Unit |
|---|-----------------|----------|-----|------|
| Oscillator Frequency | fosc | | | |
| Crystal Option | | - | 2.0 | MHz |
| External Clock Option | | dc | 2.0 | MHz |
| Internal Operating Frequency | fop | | | |
| Crystal (fosc ÷ 2) | | - | 1.0 | MHz |
| External Clock (f _{OSC} ÷ 2) | | dc | 1.0 | MHz |
| Cycle Time | tcyc | 1 | - | ms |
| Crystal Oscillator Startup Time | toxov | - | 100 | ms |
| STOP Recovery Startup Time (Crystal Oscillator) | tilch | _ | 100 | ms |
| RESET Pulse Width | t _{RL} | 1.5 | - | tcyc |
| Timer Resolution (NOTE 2) | tRESL | 4.0 | - | tcyc |
| Interrupt Pulse Width Low (Edge-Triggered) | tiliH | 250 | - | ns |
| Interrupt Pulse Period | tilil | (NOTE 3) | - | tcyc |
| OSC1 Pulse Width | toh, tol | 200 | - | ns |

| Table | 13-7. | Control | Timing | (V _{DD} | = 3.3 V | ′dc) |
|-------|-------|---------|--------|------------------|---------|------|
|-------|-------|---------|--------|------------------|---------|------|

NOTES:

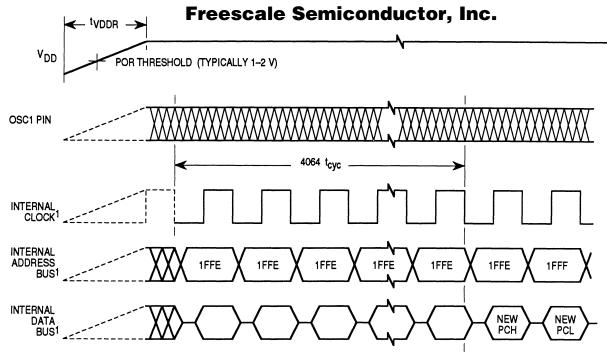
1. V_{DD} = 3.3 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H , unless otherwise noted.

- 2. Because a 2-bit prescaler in the timer must count four internal cycles (t_{CYC}), this is the limiting minimum factor in determining the timer resolution.
- 3. The minimum period t_{ILIL} should not be less than the number of cycle times it takes to execute the interrupt service routine plus 19 t_{CYC}.

MOTOROLA 13-10

ELECTRICAL SPECIFICATIONS

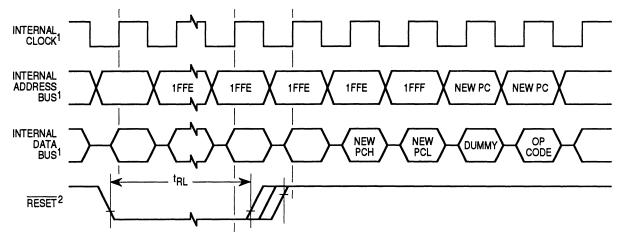
MC68HC05P6



NOTES:

1. Internal clock, internal address bus, and internal data bus are not available externally.





NOTES:

1. Internal clock, internal address bus, and internal data bus signals are not available externally.

2. Next rising edge of internal clock after rising edge of RESET initiates reset sequence.

Figure 13-8. External Reset Timing

MC68HC05P6

ELECTRICAL SPECIFICATIONS

MOTOROLA 13-11

| Characteristic | Symbol | Min | Max | Unit |
|---|--|------------|-------------|------------|
| Frequency of Operation Master Slave | fsюр(м) fsюр(s) | 0.25 dc | 0.25 525 | fop kHz |
| Cycle time Master Slave | ^t scк(м) ^t scк(s) | 4.0 | 4.0 1920 | tcyc ns |
| Clock (SCK) Low Time (fop = 2.1 MHz) | tsckl | 932 | | ns |
| SDO Data Valid Time | tv | | 200 | ns |
| SDO Hold Time | tно | 0 | | ns |
| SDI Setup Time | ts | 100 | | ns |
| SDI Hold Time | t _H | 100 | _ | ns |

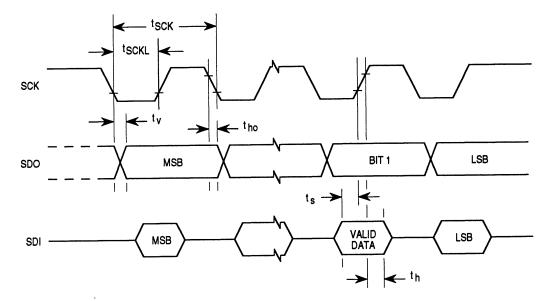
| Table | 13-8. | SIOP | Timing | (V _{DD} | = | 5.0 | Vdc) | |
|-------|-------|------|--------|------------------|---|-----|------|--|
|-------|-------|------|--------|------------------|---|-----|------|--|

NOTES:

1. V_{DD} = 5.0 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H , unless otherwise noted.

2. $f_{OP} = f_{OSC} \div 2 = 2.1$ MHz maximum; $t_{CYC} = 1 \div f_{OP}$.

3. In master mode, SCK is generated by dividing the internal clock (fop) by 4.



NOTES:

1. This diagram applies to both the master and slave modes of the SIOP.

2. Bit order is shown for MSB first option.



MOTOROLA 13-12

ELECTRICAL SPECIFICATIONS

MC68HC05P6

| Characteristic | Symbol | Min | Max | Unit |
|--|--------------------------------|------------|-------------|------------|
| Frequency of operation Master Slave | fsiop(м) fsiop(s) | 0.25 dc | 0.25 250 | fop kHz |
| Cycle time Master Slave | ^t sck(м) tsck(s) | 4.0 | 4.0 4000 | tcyc ns |
| Clock (SCK) Low Time (f _{OP} = 1.0 MHz) | tsckl | 1980 | - | ns |
| SDO Data Valid Time | tv | - | 400 | ns |
| SDO Hold Time | tно | 0 | - | ns |
| SDI Setup Time | ts | 200 | - | ns |
| SDI Hold Time | tн | 200 | _ | ns |

Table 13-9. SIOP Timing (V_{DD} = 3.3 Vdc)

NOTES:

1. V_{DD} = 3.3 Vdc ± 10%, V_{SS} = 0 Vdc, T_A = T_L to T_H , unless otherwise noted.

2. $f_{OP} = 1.0$ MHz maximum.

MC68HC05P6

ELECTRICAL SPECIFICATIONS

MOTOROLA 13-13

MOTOROLA 13-14

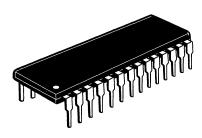
ELECTRICAL SPECIFICATIONS

MC68HC05P6

SECTION 14 MECHANICAL SPECIFICATIONS

This section gives the dimensions of the plastic dual in-line package (PDIP) and the small outline integrated circuit (SOIC) package.

14.1 PDIP



SCALE 1:1

NOTES

OTHER

FLASH

DIM A B

D

K

1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25mm (0.010) AT MAXIMUM MATERIAL CONDITION. IN RELATION TO SEATING PLANE AND EACH

2. DIMENSION L TO CENTER OF LEADS WHEN

FORMED PARALLEL. 3. DIMENSION B DOES NOT INCLUDE MOLD

4. 710-01 OBSOLETE, NEW STANDARD 710-02.

 MIN
 MAX
 MIN
 MAX

 36.45
 37.21
 1.435
 1.465

13.72 14.22 0.540 0.560

2.54 BSC 0.100 BSC 1.65 2.16 0.065 0.085

2.92 3.43 0.115 0.135

5.08 0.155 0.200

0.56 0.014 0.022

1.52 0.040 0.060

0.38 0.008 0.015

1.02 0.020 0.040

0.600 BSC

15

INCHES

MILLIMETERS

3.94

0.36

1.02

0.20

0.51

15.24 BSC 0° 15

15

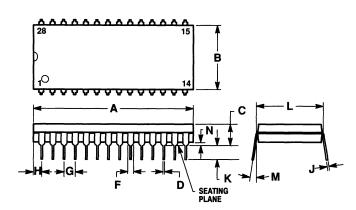


Figure 14-1. Case #710-02

MC68HC05P6

MECHANICAL SPECIFICATIONS



SCALE 1:1

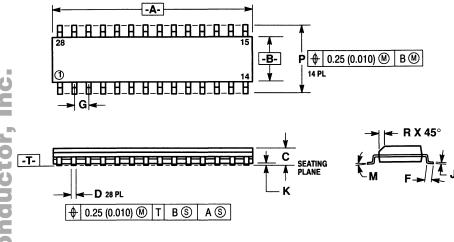


Figure 14-2. Case #751F-03

- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION. 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) DED SIDE

- MAXIMUM MODIFICITION OF 15 (0.000) PER SIDE.
 751F-01 AND -02 OBSOLETE, NEW STANDARD 751F-03.

| | MILLIMETERS INCHES | | | HES |
|-----|--------------------|------------|--------|------------|
| DIM | MIN | MAX | MIN | MAX |
| A | 17.80 | 18.05 | 0.701 | 0.711 |
| B | 7.40 | 7.60 | 0.292 | 0.299 |
| C | 2.35 | 2.65 | 0.093 | 0.104 |
| D | 0.35 | 0.49 | 0.014 | 0.019 |
| F | 0.41 | 0.90 | 0.016 | 0.035 |
| G | 1.27 | 1.27 BSC | | BSC |
| J | 0.229 | 0.317 | 0.0090 | 0.0125 |
| K | 0.127 | 0.292 | 0.0050 | 0.0115 |
| M | 0° | 8 ° | 0° | 8 ° |
| P | 10.05 | 10.55 | 0.395 | 0.415 |
| R | 0.25 | 0.75 | 0.010 | 0.029 |

Semiconductor, Inc. reescale

MOTOROLA 14-2

MECHANICAL SPECIFICATIONS

MC68HC05P6

SECTION 15 ORDERING INFORMATION

This section contains instructions for ordering custom-masked ROM MCUs.

15.1 MCU Ordering Forms

To initiate an order for a ROM-based MCU, first obtain the current ordering form for the MCU from a Motorola representative. Submit the following items when ordering MCUs:

- A current MCU ordering form that is **completely filled out** (Contact your Motorola sales office for assistance.)
- A signed XC status letter, if applicable (See 15.5 XC Status Letter.)
- A copy of the customer specification if the customer specification deviates from the Motorola specification for the MCU
- Customer's application program on one of the media listed in 15.2 Application Program Media

The current MCU ordering form is also available through the Motorola Freeware Bulletin Board Service (BBS). The telephone number is (512) 891-FREE. After making the connection, type bbs in lowercase letters and press the return key to start the BBS software.

MC68HC05P6

ORDERING INFORMATION

15.2 Application Program Media

Please deliver the application program to Motorola in one of the following media:

- Macintosh®¹ 3-1/2-inch diskette (double-sided 800K or double-sided high-density 1.4M)
- MS-DOS®² or PC-DOS®³ 3-1/2-inch diskette (double-sided 720K or double-sided high-density 1.44M)
- MS-DOS® or PC-DOS® 5-1/4-inch diskette (double-sided double-density 360K or double-sided high-density 1.2M)
- EPROM(s) 2716, 2732, 2764, 27128, 27256, or 27512 (depending on the size of the memory map of the MCU)

Use positive logic for data and addresses.

15.2.1 Diskettes

If submitting the application program on a diskette, clearly label the diskette with the following information:

- Customer name
- Customer part number
- Project or product name
- Filename of object code
- Date
- Name of operating system that formatted diskette
- Formatted capacity of diskette

On diskettes, the application program must be in Motorola's S-record format (S1 and S9 records), a character-based object file format generated by M6805 cross assemblers and linkers.

MOTOROLA 15-2 ORDERING INFORMATION

MC68HC05P6

¹ Macintosh is a registered trademark of Apple Computer, Inc.

 $^{^{2}}$ MS-DOS is a registered trademark of Microsoft, Inc.

³ PC-DOS is a registered trademark of International Business Machines Corporation.

Begin the application program at the first user ROM location. Program addresses must correspond exactly to the available on-chip user ROM addresses as shown in the memory map. Write \$00 in all non-user ROM locations or leave all non-user ROM locations blank. Refer to the current MCU ordering form for additional requirements.

If the memory map has two user ROM areas with the same addresses, then write the two areas in separate files on the diskette. Label the diskette with both filenames.

In addition to the object code, a file containing the source code can be included. Motorola keeps this code confidential and uses it only to expedite ROM pattern generation in case of any difficulty with the object code. Label the diskette with the filename of the source code.

15.2.2 EPROMs

If submitting the application program in an EPROM, clearly label the EPROM with the following information:

- Customer name
- Customer part number
- Checksum
- Project or product name
- Date

NOTE

Begin the application program at the first user ROM location. Program addresses must correspond exactly to the available on-chip user ROM addresses as shown in the memory map. Write \$00 in all non-user ROM locations. Refer to the current MCU ordering form for additional requirements.

MC68HC05P6

ORDERING INFORMATION

Freescale Semiconductor, Inc. Submit the application program in one EPROM large enough to contain the entire memory map. If the memory map has two user ROM areas with the same addresses, then write the two areas on separate EPROMs. Label the EPROMs with the addresses they contain.

Pack EPROMs securely in a conductive IC carrier for shipment. Do not use Styrofoam.

15.3 ROM Program Verification

The primary use for the on-chip ROM is to contain the customer's application program. The customer develops and debugs the application program and then submits the MCU order along with his application program.

Motorola inputs the customer's application program code into a computer program that generates a listing verify file. The listing verify file represents the memory map of the MCU. The listing verify file contains the user ROM code and may also contain non-user ROM code, such as self-check code. Motorola sends the customer a computer printout of the listing verify file along with a listing verify form.

To aid the customer in checking the listing verify file, Motorola will program the listing verify file into customer-supplied blank EPROMs or preformatted Macintosh or DOS disks. All original pattern media are filed for contractual purposes and are not returned.

Check the listing verify file thoroughly, then complete and sign the listing verify form and return the listing verify form to Motorola. The signed listing verify form constitutes the contractual agreement for the creation of the custom mask.

MOTOROLA 15-4

ORDERING INFORMATION

MC68HC05P6

15.4 ROM Verification Units (RVUs)

After receiving the signed listing verify form, Motorola manufactures a custom photographic mask. The mask contains the customer's application program and is used to process silicon wafers. The application program cannot be changed after the manufacture of the mask begins. Motorola then produces ten MCUs, called RVUs, and sends the RVUs to the customer. RVUs are usually packaged in unmarked ceramic and tested to 5 Vdc at room temperature. RVUs are not tested to environmental extremes because their sole purpose is to demonstrate that the customer's user ROM pattern was properly implemented. The ten RVUs are free of charge with the minimum order quantity but are not production parts. RVUs are not guaranteed by Motorola Quality Assurance.

15.5 XC Status Letter

The XC status letter is for customer acknowledgement that the MCU is a pilot production device. As a pilot production device, the MCU part number has an XC prefix. When the MCU meets all of Motorola's formal quality and reliability requirements, the XC prefix is replaced with MC. The MCU ordering form indicates whether or not the MCU order requires an XC status letter.

MC68HC05P6

ORDERING INFORMATION

MOTOROLA 15-5

MOTOROLA 15-6 ORDERING INFORMATION

MC68HC05P6

Date:

To:

Subject: XC Status of Device

The XC prefix indicates that the MCU has yet to meet Motorola's formal quality and reliability requirements and is still in the pilot production phase. The pilot production phase lasts approximately six months as the necessary qualification and stress tests are completed to bring the MCU to fully qualified MC status. The manufacture of XC MCUs is similar to the manufacture of standard production MCUs and includes the following:

- Processing per production shop order
- 100% testing per current data sheet
- Standard QA inspection and tests
- Complete traceability
- Preliminary reliability testing

John H. Sayce Reliability and Quality Assurance Manager Advanced Microcontroller Division/CSIC Microcontroller Division

Customer representative: Please sign below and return this letter to the following address:

Motorola CSIC Microcontroller Division 6501 William Cannon Drive West Austin, TX 78735 Mail Drop OE 39

Customer Representative

Title

Date

MC68HC05P6

ORDERING INFORMATION

MOTOROLA 15-8 ORDERING INFORMATION

MC68HC05P6

Literature Distribution Centers:

USA: Motorola Literature Distribution; P.O. Box 20912; Phoenix, Arizona 85036. EUROPE: Motorola Ltd.; European Literature Centre; 88 Tanners Drive, Blakelands, Milton Keynes, MK14 5BP, England. JAPAN: Nippon Motorola Ltd.; 4-32-1, Nishi-Gotanda, Shinagawa-ku, Tokyo 141 Japan.

ASIA-PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Center, No. 2 Dai King Street, Tai Po Industrial Estate, Tai Po, N.T., Hong Kong.



For More Information On This Product, Go to: www.free**string.com** MC68HC05P6/D